

SEMICONDUCTORS

3501 ED BLUESTEIN BLVD., AUSTIN, TEXAS 78721

Advance Information

MC68(7)05R/U SERIES

8-BIT MICROCOMPUTERS

JANUARY, 1984

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SECTION 1 INTRODUCTION

The M6805 Family of low-cost single-chip microcomputers was designed for the user who needs an economical microcomputer with the proven capabilities of the M6800-based instruction set. This rapidly expanding family includes a number of memory and package sizes with various I/O functions in both HMOS and CMOS.

This document describes the eight 8-bit high-density N-channel silicon-gate microcomputers which comprise the MC68(7)05R/U series. These devices are listed below:

MC6805R2

MC6805R3

MC68705R3

MC68705R5

MC6805U2

MC6805U3

MC68705U3

MC68705U5

These eight devices are 8-bit high-density N-channel silicon-gate microcomputers. They are available in 40-pin dual-in-line packages.

1.1 DEVICE FEATURES

The following tables summarize the hardware and software features of each device. Differences between the devices will be highlighted throughout this document when applicable.

HARDWARE FEATURES

| | MC6805R2 | MC6805R3 | MC6805U2 | MC6805U3 | MC68705R3 | MC68705U3 | MC68705R5 | MC68705U5 |
|-----------------------------------|----------|----------|----------|----------|-----------|-------------|-----------|--------------|
| 24 Bidirectional | х | × | × | × | × | × | × | × |
| Eight Input-Only Lines | X | X | × | x | X | × | × | \ |
| A/D Converter | X | × | | | × | | X | <u> </u> |
| User ROM (Bytes) | 2048 | 3776 | 2048 | 3776 | | | | |
| User EPROM (Bytes) | _ | _ | _ | _ | 3776 | 3776 | 3776 | 3776 |
| RAM (Bytes) | 64 | 112 | 64 | 112 | 112 | 112 | 112 | 112 |
| Self-Check Mode | Х | Х | X | Х | _ | - | _ | _ |
| Zero/Crossing Detect/Interrupt | х | X | Х | Х | × | х | х | X |
| Timer with 7-Bit Prescaler | x | X | X | X | × | X | × | × |
| Programmable Prescaler | _ | _ | X | × | X | × | × | × |
| 5-Volt Single Supply | Х | Х | Х | Х | Х | Х | Х | Х |
| Memory Mapped I/O | Х | Х | Х | Х | Х | X | X | X |
| On-Chip EPROM Programmer | _ | _ | | _ | х | х | х | x |
| EPROM Security Feature | _ | | _ | _ | _ | _ | × | х |

SOFTWARE FEATURES

| | MC6805R2 | MC6805R3 | MC6805U2 | MC6805U3 | MC68705R3 | MC68705U3 | MC68705R5 | MC68705U5 |
|--|----------|----------|----------|----------|-----------|-----------|-----------|-----------|
| Addressing Modes | 10 | 10 | 10 | 10 | 10 | 10 | 10 | 10 |
| Byte Efficient Instruction Set | Х | х | х | × | × | х | х | × |
| True Bit Manipulation | Х | X | X | Х | Х | Х | X | × |
| Bit Test and Branch Instructions | х | х | х | × | х | х | х | х |
| Versatile Interrupt Handling | х | x | х | x | × | х | х | х |
| Versatile Index Register | × | х | х | х | × | х | X | × |
| Powerful Indexed Addressing for Tables | × | × | × | x | × | × | × | × |
| Full Set of Condi- tional Branches | X | x | х | х | × | x | x | × |
| Memory Usable as Registers/Flags | х | x | x | х | × | x | × | × |
| Single Instruction Memory Examine/ Change | × | × | × | x | × | × | × | × |
| User Callable Self- Check Subroutines | х | x | х | х | _ | _ | - | _ |
| Complete Develop- ment System Sup- port on EXORciser | × | × | × | x | × | × | × | × |
| Supported by EPROM Version | х | x | × | x | _ | _ | _ | - |

1.2 HARDWARE

Every M6805 Family microcomputer contains hardware common to all versions, plus a combination of options unique to a particular version. Figures 1-1 through 1-6 illustrate the unique options available on the eight versions described in this document.

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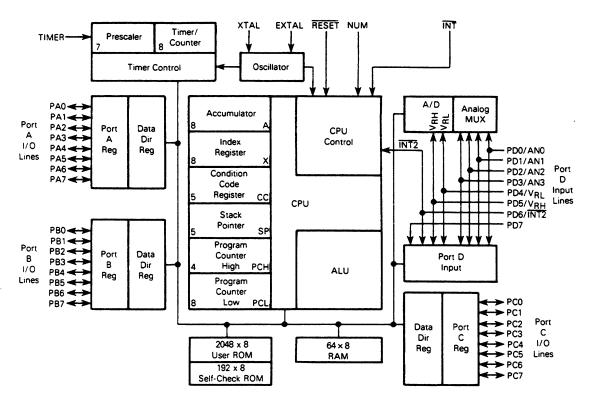


Figure 1-1. MC6805R2 Block Diagram

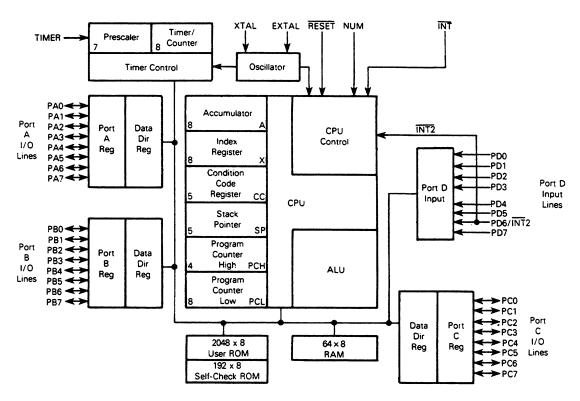


Figure 1-2. MC6805U2 Block Diagram

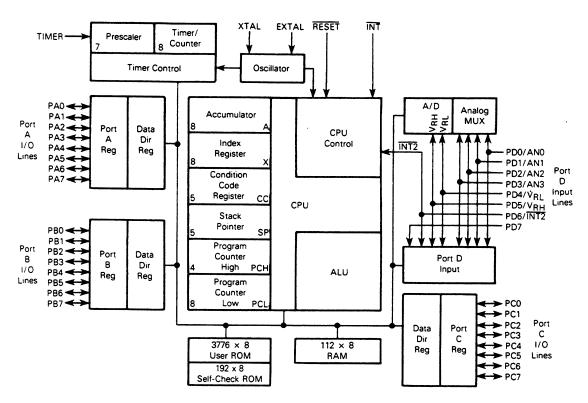


Figure 1-3. MC6805R3 Block Diagram

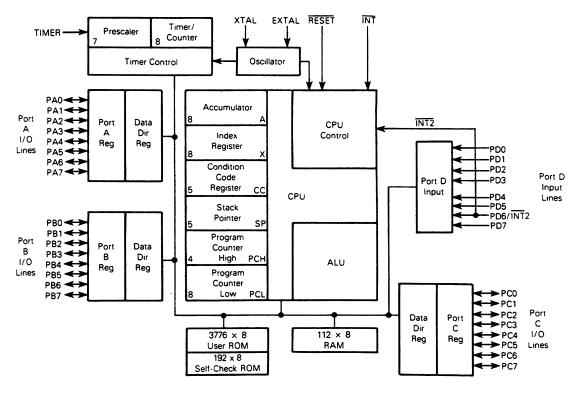


Figure 1-4. MC6805U3 Block Diagram

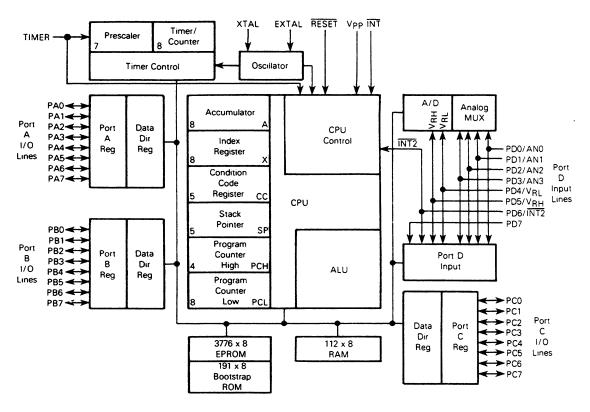


Figure 1-5. MC68705R3 and MC68705R5 Block Diagram

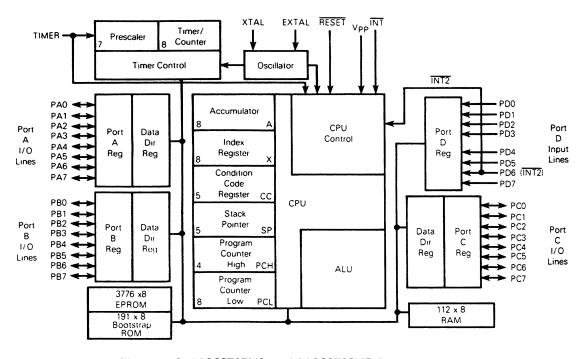


Figure 1-6. MC68705U3 and MC68705U5 Block Diagram

| | · | | · |
|--|---|--|---|
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SECTION 2 SIGNAL DESCRIPTION

The following paragraphs contain brief descriptions of the input and output signals. Where applicable reference has been made to other sections that contain more detail about the function being performed.

2.1 VCC AND VSS

Power is supplied to the microcomputers using these two pins. VCC is power and VSS is the ground connection.

2.2 INT

This pin provides the capability for asynchronously applying an external interrupt to the microcomputer. Refer to SECTION 7 RESET, CLOCK, AND INTERRUPT STRUCTURE for additional information regarding the interrupt operation.

2.3 EXTAL AND XTAL

These pins provide control input for the on-chip clock oscillator circuit. A crystal, a resistor, or an external signal, depending on user selectable manufacturing mask option, can be connected to these pins to provide a system clock with various degrees of stability/cost tradeoffs. Lead length and stray capacitance on these two pins should be minimized. Refer to SECTION 7 RESET, CLOCK, AND INTERRUPT STRUCTURE for recommendations about these inputs.

2.4 TIMER

This pin is used as an external input to control the internal timer/counter circuitry. On the MC68705R3, MC68705U3, MC68705R5, and MC68705U5 versions, this pin also detects a higher voltage level used to initiate the bootstrap program for loading the internal EPROM (see **SECTION 10 SOFTWARE**). On the MC6805R2, MC6805U2, MC6805R3, and MC6805U3 this pin also detects a higher voltage level used to initiate the self-test program (see **SECTION 6 SELF CHECK**).

Refer to **SECTION 5 TIMER** for more detailed information about the timer circuitry.

2.5 RESET

This pin has a Schmitt trigger input and an on-chip pullup. The microcomputer can be reset by pulling RESET low. Refer to SECTION 7 RESET, CLOCK, AND INTERRUPT STRUCTURE for additional information.

2.6 NUM (NON-USER MODE)

Pin 7 of the MC6805R2 and MC6805U2 is identified as NUM (non-user mode). This pin is not for user application and must be connected to VSS.

2.7 Vpp

This pin is used when programming the EPROM versions (MC68705R3, MC68705U3, MC68705R5, and MC68705U5). By applying the programming voltage to this pin, one of the requirements is met for programming the EPROMs. In normal operation, this pin is connected to VCC. Refer to **SECTION 9 MASK OPTIONS AND PROGRAMMING** for more detailed information.

2.8 INPUT/OUTPUT LINES (PAO-PA7, PBO-PB7, PCO-PC7, PDO-PD7)

These 32 lines are arranged into four 8-bit ports (A, B, C, and D). Ports A, B, and C are programming as either inputs or outputs under software control of the data direction registers.

For the MC6805U2, MC6805U3, MC68705U3, and MC68705U5 port D is for digital input only and bit 6 may be used for a second interrupt (INT2). Refer to SECTION 7 RESET, CLOCK, AND INTER-RUPT STRUCTURE and SECTION 8 INPUT/OUTPUT CIRCUITRY AND ANALOG-TO-DIGITAL CONVERTER for additional information.

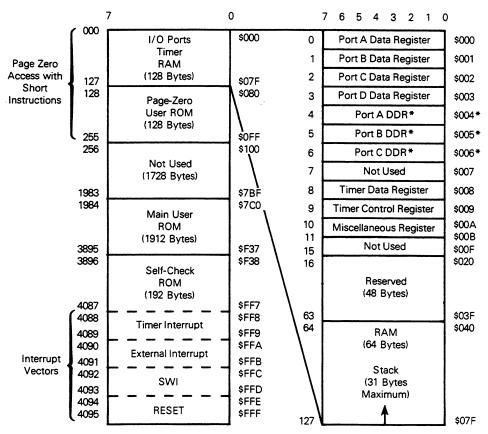
For the MC6805R2, MC6805R3, MC68705R3, and MC68705R5 port D has up to four analog inputs, plus two voltage reference inputs when the analog-to-digital converter is used (PD5/VRH, PD4/VRL) and an INT2 input. All port D lines can be read directly and used as binary inputs. If any analog input is used, then the voltage reference pins (PD5/VRH, PD4/VRL) must be used in the analog mode. Refer to SECTION 7 RESET, CLOCK, AND INTERRUPT STRUCTURE and SECTION 8 INPUT/OUTPUT CIRCUITRY AND ANALOG-TO-DIGITAL CONVERTER for additional information.

SECTION 3 MEMORY CONFIGURATIONS

Each member of the MC68(7)05R/U series of microcomputers is capable of addressing 4096 bytes of memory and I/O registers. The memory maps for the eight versions of the M6805 Family described in this document are shown in Figures 3-1 through 3-6. The amount of ROM, EPROM, and RAM for each device is detailed in 1.1 DEVICE FEATURES.

3.1 MC6805U2 MEMORY MAP

The memory map for the MC6805U2 is shown in Figure 3-1. From \$FF8 to \$FFF are the interrupt and RESET vectors. A self-check ROM occupies 192 bytes from \$F38 to \$FF7. The user ROM is



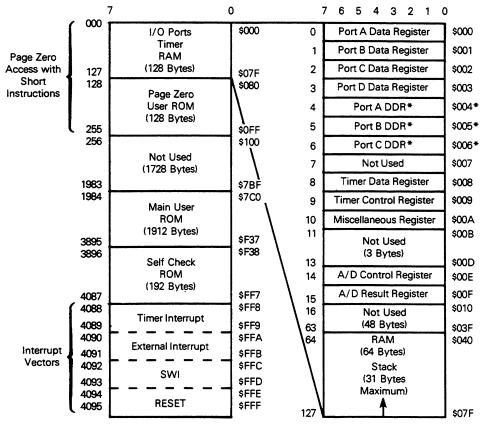
^{*}Caution: Data direction registers (DDRs) are write-only; they read as \$FF.

Figure 3-1. MC6805U2 Memory Map

divided into two portions located from \$080 to \$0FF and \$7C0 to \$F37. The portioning allows 128 bytes of ROM to be addressed with direct instructions. A RAM area of 64 bytes occupies \$040 to \$07F. Only the 31 bytes from \$061 to \$07F can be used for the stack RAM due to the limitation imposed by the 5-bit stack pointer. The data direction, peripheral data, timer, and miscellaneous registers are located from \$000 to \$00F.

3.2 MC6805R2 MEMORY MAP

The memory map for the MC6805R2 is shown in Figure 3-2 and is identical to the MC6805U2 except that two additional registers, the analog-to-digital control register and the analog-to-digital result register, have been added at locations \$00E and \$00F, respectively.

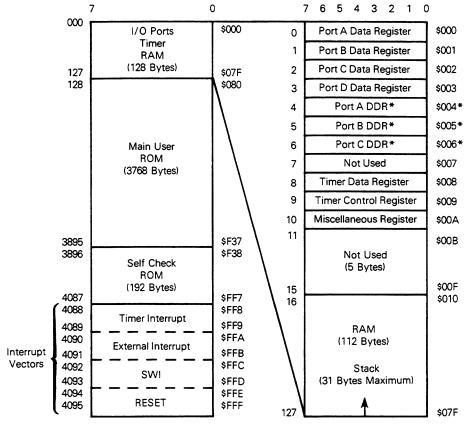


^{*}Caution: Data direction registers (DDRs) are write-only; they read as \$FF.

Figure 3-2. MC6805R2 Memory Map

3.3 MC6805U3 MEMORY MAP

The memory map for the MC6805U3 is shown in Figure 3-3. The MC6805U3 has an expanded ROM and RAM area over the MC6805U2. The user ROM in the MC6805U3 consists of 3768 bytes from \$080 to \$F37. The RAM is expanded to 112 bytes from \$010 to \$07F. All other registers remain identical to the MC6805U2. The 5-bit stack pointer still allows only 31 bytes of RAM to be used as stack area.

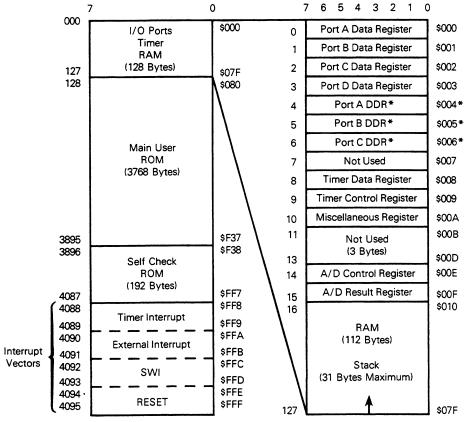


^{*}Caution: Data direction registers (DDRs) are write-only; they read as \$FF.

Figure 3-3. MC6805U3 Memory Map

3.4 MC6805R3 MEMORY MAP

The memory map for the MC6805R3 is shown in Figure 3-4 and is identical to the MC6805U3 except that two additional registers, the analog-to-digital control register and the analog-to-digital result register, have been added at locations \$00E and \$00F, respectively.



^{*}Caution: Data direction registers (DDRs) are write-only; they read as \$FF.

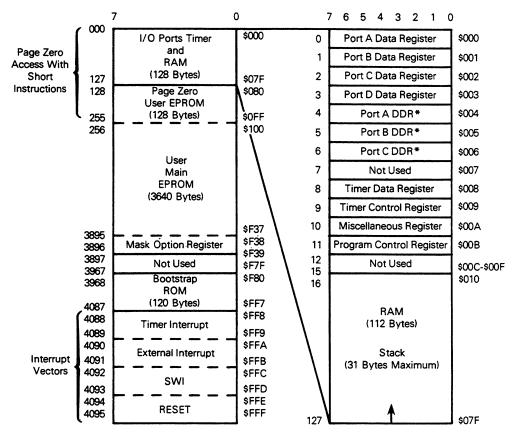
Figure 3-4. MC6805R3 Memory Map

3.5 MC68705U3 and MC68705U5 MEMORY MAP

The memory maps for the MC68705U3 and MC68705U5 are shown in Figure 3-5 and are identical to the masked programmed equivalent, the MC6805U3, with respect to RAM, ROM, I/O, special purpose registers, and interrupt and RESET vectors. The ROM area (\$080 to \$F37) of the MC68705U3 and MC68705U5 is an ultraviolet erasable EPROM.

A bootstrap ROM is located between \$F39 and \$FF7 which allows the MC68705U3 and MC68705U5 to program their own EPROMs. The bootstrap is a mask programmed ROM.

At location \$F38 is the mask option register (MOR) which is an EPROM byte. It allows the user to set up the MC68705U3 and the MC68705U5 for a crystal or RC oscillator, set the timer prescaler, the clock source, etc. In addition, the mask option register allows the user to select the secure mode offered by the MC68705U5.



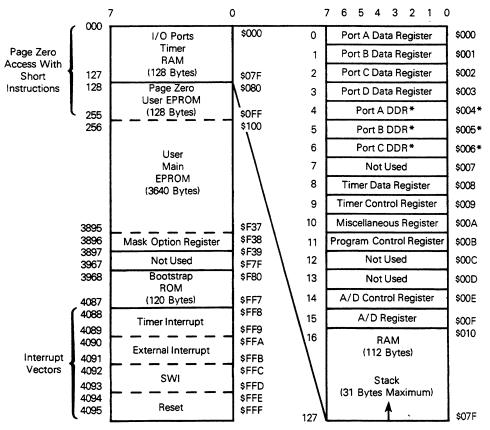
^{*}Caution: Data direction registers (DDRs) are write-only; they read as \$FF.

Figure 3-5. MC68705U3 and MC68705U5 Memory Map

3.6 MC68705R3 and MC68705R5 MEMORY MAP

The memory maps for the MC68705R3 and MC68705R5 are shown in Figure 3-6 and are identical to the MC68705U3 and MC68705U5 except that two additional registers, the analog-to-digital control register and the analog-to-digital result register have been added at locations \$00E and \$00F, respectively.

The MC68705U3/MC68705U5 and MC68705R3/MC68705R5 are intended to exactly emulate the MC6805U3 and MC6805R3 respectively.

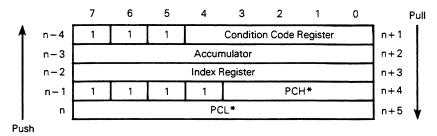


^{*}Caution: Data direction registers (DDRs) are write-only; they read as \$FF.

Figure 3-6. MC68705R3 and MC68705R5 Memory Map

3.7 SHARED STACK AREA

The shared stack area (RAM locations \$061-\$07F) is used during the processing of an interrupt or subroutine call to save the contents of the central processing unit state. The register contents are pushed onto the stack in the order shown in Figure 3-7. Since the stack pointer decrements during pushes, the low order byte (PCL) of the program counter is stacked first, then the high order four bits (PCH) are stacked. This ensures that the program counter is loaded correctly during pulls from the stack since the stack pointer increments when it pulls data from the stack. A subroutine call results in only the program counter (PCL, PCH) contents being pushed onto the stack; the remaining CPU registers are not pushed. The shared stack area must be used with care when it is used for data storage or temporary work locations to protect it from being overwritten due to stacking from an interrupt or subroutine call.



^{*}For subroutine calls, only PCH and PCL are stacked.

Figure 3-7. Interrupt Stacking Order

3.8 CENTRAL PROCESSING UNIT

The central processing unit for the M6805 Family is implemented independently from the I/O or memory configuration. Consequently, it can be treated as an independent central processor communicating with I/O and memory via internal address, data, and control buses.

SECTION 4 PROGRAMMABLE REGISTERS

The M6805 Family CPU has five registers available to the programmer. They are shown in Figure 4-1 and are explained in the following paragraphs.

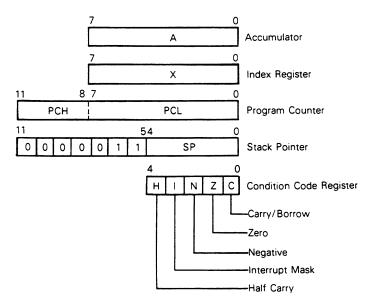


Figure 4-1. Programming Model

4.1 ACCUMULATOR (A)

The accumulator is a general purpose 8-bit register used to hold operands and results of arithmetic calculations or data manipulations.

4.2 INDEX REGISTER (X)

The index register is an 8-bit register used for the indexed addressing mode. It contains an 8-bit value that may be added to an 8- or 16-bit immediate value to create an effective address. The index register may also be used as a temporary storage area.

4.3 PROGRAM COUNTER (PC)

The program counter is a 12-bit register that contains the address of the next bye to be fetched.

4.4 STACK POINTER (SP)

The stack pointer is a 12-bit register that contains the address of the next free location on the stack. During an MCU reset or the reset stack pointer (RSP) instruction, the stack pointer is set to location \$07F. The stack pointer is then decremented as data is pushed onto the stack and incremented as data is pulled from the stack. The seven most significant bits of the stack pointer are permanently set to 0000011. Subroutines and interrupts may be nested down to location \$061 (31 bytes maximum) which allows the programmer to use up to 15 levels of subroutine calls (less if interrupts are allowed).

4.5 CONDITION CODE REGISTER (CC)

The condition code register is a 5-bit register in which four bits are used to indicate the results of the instruction just executed. These bits can be individually tested by a program and specific action taken as a result of their state. Each bit is explained in the following paragraphs.

4.5.1 Half Carry (H)

Set during ADD and ADC operations to indicate that a carry occurred between bits 3 and 4.

4.5.2 Interrupt (I)

When this bit is set, the timer and external interrupts ($\overline{\text{INT}}$ and $\overline{\text{INT2}}$) are masked (disabled). If an interrupt occurs while this bit is set, the interrupt is latched and is processed as soon as the interrupt bit is cleared.

4.5.3 Negative (N)

When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was negative (bit 7 in the result is a logic one).

4.5.4 Zero (Z)

When set, this bit indicates that the result of the last arithmetic, logical, or data manipulation was zero.

4.5.5 Carry/Borrow (C)

When set, this bit indicates that a carry or borrow out of the arithmetic logical unit (ALU) occurred during the last arithmetic operation. This bit is also affected during bit test and branch instructions plus shifts and rotates.

SECTION 5 TIMER

The following paragraphs describe the timer circuitry for the eight versions of the M6805 Family found in this document. Note that while each timer consists of an 8-bit software programmable counter driven by a 7-bit prescaler there are three distinctly different configurations (Figures 5-1, 5-2, and 5-3).

5.1 MC6805R2/MC6805U2 TIMER CIRCUITRY

The timer circuitry for the MC6805R2 and MC6805U2 microcomputers is shown in Figure 5-1. The 8-bit counter may be loaded under program control and is decremented toward zero by the clock input (or prescaler output). When the timer reaches zero, the timer interrupt request bit (bit 7) in the timer control register (TCR) is set. The timer interrupt can be masked (disabled) by setting the timer interrupt mask bit (bit 6) in the TCR. The interrupt bit (I bit) in the condition code register also prevents a timer interrupt from being processed. The MCU responds to this interrupt by saving the present CPU state on the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9 and executing the interrupt routine (see **SECTION 7 RESET, CLOCK, AND INTERRUPT STRUCTURE**). The timer interrupt request bit must be cleared by software. The TIMER and INT2 share the same interrupt vector. The interrupt routine must check the request bits to determine the source of the interrupt.

The clock input to the timer can be from an external source (decrementing of timer counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal phase two signal. Three machine cycles are required for a change in state of the TIMER pin to

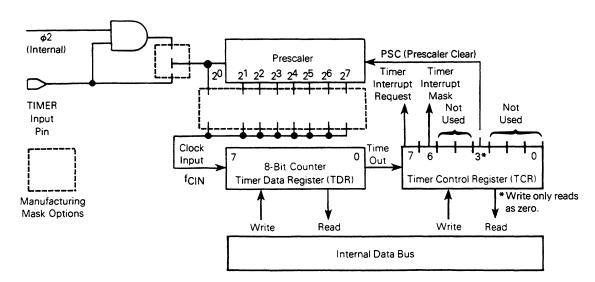


Figure 5-1. MC6805R2/MC6805U2 Timer Block Diagram

decrement the timer prescaler. The maximum frequency of a signal that can be recognized by the TIMER pin logic is dependent on the parameter labeled twl, twh. The pin logic that recognizes the high state on the pin must also recognize the low state on the pin in order to "re-arm" the internal logic. Therefore, the period can be calculated as follows (assumes 50/50 duty cycle for a given period):

$$t_{CYC} \times 2 + 250 \text{ ns} = \text{period} = \frac{1}{\text{freq}}$$

The period is not simply twL + twH. This computation is allowable, but it does reduce the maximum allowable frequency by defining an unnecessarily longer period (250 nanoseconds times two).

When the phase two signal is used as the source, it can be gated by an input applied to the TIMER input pin allowing the user to easily perform pulse-width measurements. The source of the clock input is one of the mask options that is specified before manufacture of the MCU.

NOTE

For ungated phase two clock input to the timer prescaler, the TIMER pin should be tied to VCC.

A prescaler option, divide by 2ⁿ, can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter. This prescaling mask option is also specified before manufacture. To avoid truncation errors, the prescaler is cleared when bit 3 of the timer control register is written to a logic one (this bit always reads a logic zero).

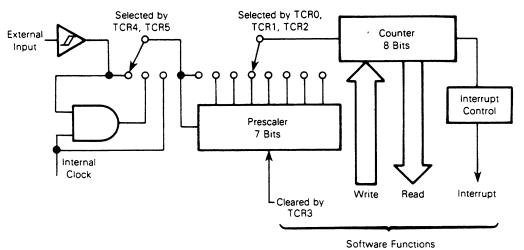
The timer continues to count past zero, falling through to \$FF from \$00 and then continuing the countdown. Thus, the counter can be read at any time by reading the timer data register (TDR). This allows a program to determine the length of time since a timer interrupt has occurred, and not disturb the counting process.

At power up or reset, the prescaler and counter are initialized with all logic ones; the timer interrupt request bit (bit 7) is cleared and the timer interrupt mask bit (bit 6) is set.

5.2 MC6805R3/MC6805U3 TIMER CIRCUITRY

The timer circuitry for the MC6805R3/MC6805U3 microcomputers is shown in Figure 5-2. The timer contains a single 8-bit software programmable counter with 7-bit software selectable prescaler. The counter may be preset under program control and decrements toward zero. When the counter decrements to zero, the timer interrupt request bit, i.e., bit 7 of the timer control register (TCR), is set. Then if the timer interrupt is not masked, i.e., bit 6 of the TCR and the I bit in the condition code register are both cleared, the processor receives an interrupt. After completion of the current instruction, the processor proceeds to store the appropriate registers on the stack, and then fetches the timer interrupt vector from locations \$FF8 and \$FF9 in order to begin servicing the interrupt.

The counter continues to count after it reaches zero, allowing the software to determine the number of internal or external input clocks since the timer interrupt request bit was set. The counter may be read at any time by the processor without disturbing the count. The contents of the counter become stable prior to the read portion of a cycle and do not change during the read. The timer interrupt request bit remains set until cleared by the software. If a write occurs before the timer interrupt is serviced, the interrupt is lost. TCR7 may also be used as a scanned status bit in a non-interrupt mode of operation (TCR=1).



NOTES:

- 1. The prescaler and 8-bit counter are clocked on the rising edge of the internal clock (phase two) or external input.
- 2. The counter is written to during data strobe (DS) and counts down continuously.

Figure 5-2. MC6805R3/MC6805U3 Timer Block Diagram

The prescaler is a 7-bit divider which is used to extend the maximum length of the timer. Bit 0, bit 1, and bit 2 of the TCR are programmed to choose the appropriate prescaler output which is used as the counter input. The processor cannot write into or read from the prescaler; however, its contents are cleared to all zeros by the write operation into TCR when bit 3 of the written data equals one, which allows for truncation-free counting.

The timer input can be configured for three different operating modes, plus a disable mode, depending on the value written to the TCR4 and TCR5 control bits. Refer to **5.2.5 Timer Control Register (TCR)** for further information.

5.2.1 Timer Input Mode 1

If TCR5 and TCR4 are both programmed to a zero, the input to the timer is from an internal clock and the external TIMER input is disabled. The internal clock mode can be used for periodic interrupt generation, as well as a reference in frequency and event measurement. The internal clock is the instruction cycle clock.

5.2.2 Timer Input Mode 2

With TCR5=0 and TCR4=1, the internal clock and the TIMER input pin are ANDed to form the timer input signal. This mode can be used to measure external pulse widths. The external timer input pulse simply turns on the internal clock for the duration of the pulse widths.

5.2.3 Timer Input Mode 3

If TCR5=1 and TCR4=0, then all inputs to the timer are disabled.

5.2.4 Timer Input Mode 4

If TCR5=1 and TCR4=1, the internal clock input to the timer is disabled and the TIMER input pin

becomes the input to the timer. The external TIMER pin can, in this mode, be used to count external events as well as external frequencies for generating periodic interrupts.

5.2.5 Timer Control Register (TCR)

| | | | | | | | | 1 |
|------|-------------|------|------|-------|------|------|------|-------|
| TCR7 | TCR6 | TCR5 | TCR4 | TCR3* | TCR2 | TCR1 | TCR0 | \$009 |

^{*}Write only (read as zero)

- TCR7 Timer interrupt request bit: indicates the timer interrupt when it is a logic one.
 - 1—Set whenever the counter decrements to zero, or under program control.
 - 0 Cleared on external reset, power-on reset, or program control (write).
- TCR6 Timer interrupt mask bit: inhibits the timer interrupt to the processor, when this bit is a logic one.
 - 1—Set on external reset, power-on reset, or program control.
 - 0—Cleared under program control.
- TCR5 External or internal bit: selects the input clock source to be either the external TIMER pin or the internal clock (unaffected by RESET).
 - 1—Select external clock source. Set to a logic one on external reset, power-on reset, or program control.
 - 0-Select internal clock source (phase two). Cleared under program control.
- TCR4 External enable bit: control bit used to enable the external TIMER pin (unaffected by RESET).
 - 1 Enable external TIMER pin. Set on external reset, power-on reset, or program control.
 - 0-Disable external TIMER pin. Cleared under program control.

TCR5 TCR4

- 0 0 Internal clock to timer
- 1 AND of internal clock and TIMER pin to timer
- 0 Input to timer disabled
- 1 1 TIMER pin to timer
- TCR3 Timer prescaler reset bit: writing a one to this bit resets the prescaler to zero. A read of this location always indicates a zero (unaffected by RESET).
- TCR2, TCR1, and TCR0 Prescaler address bits: decoded to select one of eight outputs of the prescaler (set to all ones by RESET).

PRESCALER

| | TCR2 | TCR1 | TCR0 | Result |
|---|------|------|------|--------|
| i | 0 | 0 | 0 | ÷1 |
| | 0 | 0 | 1 | ÷2 |
| | 0 | 1 | 0 | ÷4 |
| | 0 | 1 | 1 | ÷8 |

| TCR2 | TCR1 | TCR0 | Result |
|------|------|------|--------|
| 1 | 0 | 0 | ÷ 16 |
| 1 | 0 | 1 | ÷32 |
| 1 | 1 | 0 | ÷64 |
| 1 | 1 | 1 | ÷ 128 |

5.3 MC68705R3/MC68705U3 AND MC68705R5/MC68705U5 TIMER CIRCUITRY

The timer for the MC68705R3 and MC68705U3 microcomputers is shown in Figure 5-3 and the timer for the MC68705R5 and MC68705U5 microcomputers is shown in Figure 5-4. The timer for all four devices contains an 8-bit software programmable counter which is driven by a 7-bit prescaler with one-of-eight selectable outputs. Various timer clock sources may be selected ahead of the prescaler and counter. The timer selections are made via the timer control register (TCR) and/or the mask option register (MOR). The TCR also contains the interrupt control bits. Note that the MC68705R5 and MC68705U5 offer a secure/non-secure mode option which is implemented through bit 3 of the mask option register (refer to SECTION 9 MASK OPTIONS AND PROGRAMMING for further information regarding the secure/non-secure mode option).

The 8-bit counter may be loaded under program control and is decremented toward zero by the counter input frequency (fclN) input (output of the prescaler selector). Once the 8-bit counter has decremented to zero, it sets the TIR (timer interrupt request) bit 7 (b7 of TCR). The TIM (timer interrupt mask) bit (b6) can be software set to inhibit the interrupt request, or software cleared to pass the interrupt request to the processor. When the I bit in the condition code register is cleared, the processor receives the timer interrupt. The MCU responds to this interrupt by saving the present CPU state on the stack, fetching the timer interrupt vector from locations \$FF8 and \$FF9, and executing the interrupt routine. The processor is sensitive to the level of the timer interrupt request line; therefore if the interrupt is masked, the TIR bit may be cleared by software (e.g., BCLR) without generating an interrupt. The TIR bit must be cleared by the timer interrupt service routine to clear the timer interrupt request.

The timer interrupt and $\overline{\text{INT2}}$ share the same interrupt vector. The interrupt routine thus must check the two request bits to determine the source of the interrupt.

The counter continues to count (decrement) by falling through to \$FF from zero. Thus, the counter can be read at any time by the processor without disturbing the count. This allows a program to determine the length of time since the occurrence of a timer interrupt and does not disturb the counting process.

The clock input to the timer can be from an external source (decrementing the counter occurs on a positive transition of the external source) applied to the TIMER input pin, or it can be the internal phase two signal. The maximum frequency of a signal that can be recognized by the TIMER or INT pin logic is dependent on the parameter labeled twl, twh. The pin logic that recognizes the low (or high) state on the pin in order to "re-arm" the internal logic. Therefore, the period can be calculated as follows (assumes 50/50 duty cycle for a given period):

$$t_{CYC} \times 2 + 250 \text{ ns} = \text{period} = \frac{1}{\text{freq}}$$

The period is not simply twu + twh. This computation is allowable, but it does reduce the maximum allowable frequency by defining an unnecessarily longer period (250 nanoseconds twice).

When the phase two signal is used as the source, it can be gated by an input applied to the TIMER pin allowing the user to easily perform pulse width measurements. The source of the clock input is selected via the TCR or the MOR as described later.

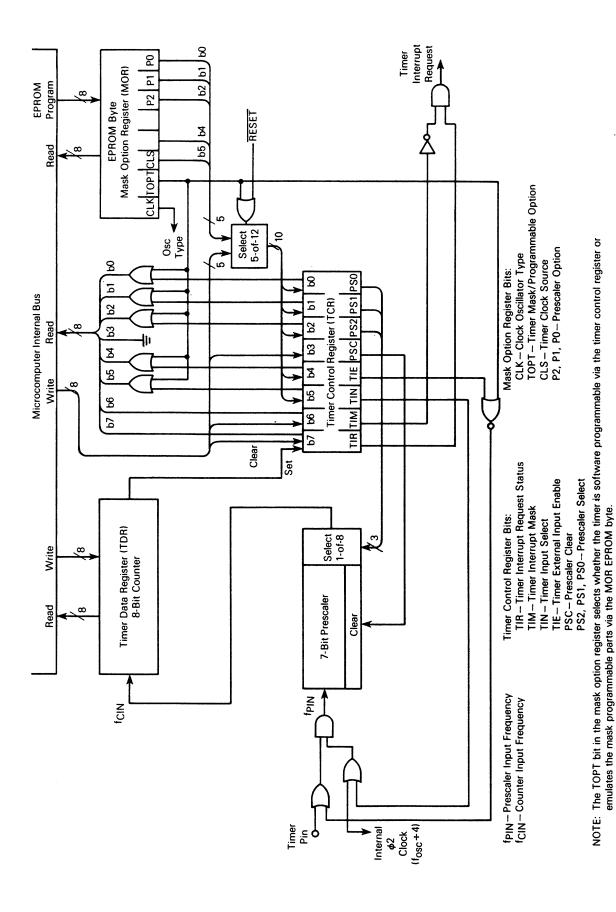


Figure 5-3. MC68705R3/MC68705U3 Timer Block Diagram

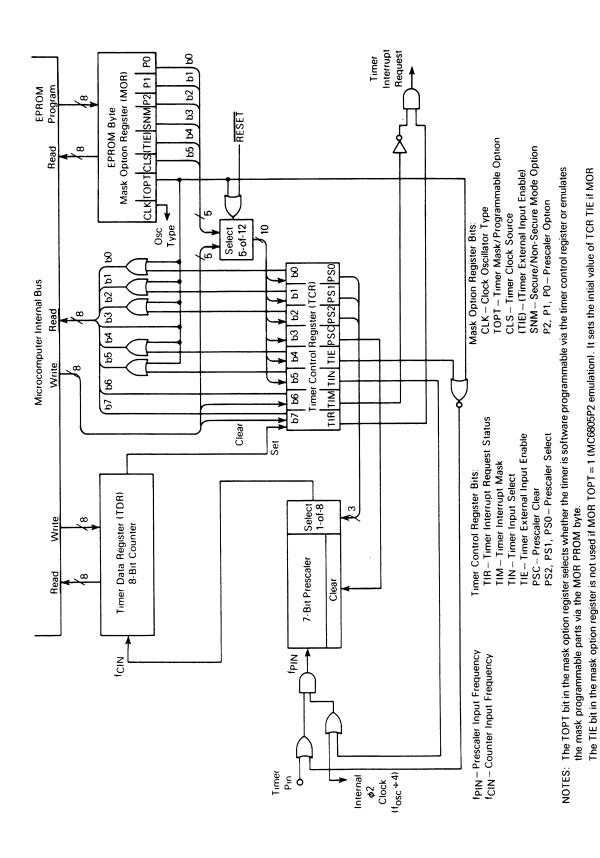


Figure 5-4. MC68705R5/MC68705U5 Timer Block Diagram

TOPT = 0.

A prescaler option can be applied to the clock input that extends the timing interval up to a maximum of 128 counts before decrementing the counter. This prescaling TCR or MOR option selects one of eight outputs on the 7-bit binary divider; one output bypasses prescaling. To avoid truncation errors, the prescaler is cleared when bit 3 (b3) of the TCR is written to a logic one; however, TCR bit 3 always reads as a logic zero to ensure proper operation with read-modify-write instructions (bit set and clear for example).

At reset, the prescaler and counter are initialized to an all ones condition; the timer interupt request bit (TCR, b7) is cleared and the timer interrupt request mask (TCR, b6) is set. TCR bits b0, b1, b2, b4, and b5 are initialized by the corresponding mask option register (MOR) bits at reset. They are then software selectable after reset (if the TOPT bit (b6) in the MORE is equal to zero).

Note that the timer block diagrams in Figures 5-3 and 5-4 reflect two separate timer control configurations: a) software controlled mode via the timer control register (TCR), and b) MOR controlled mode to emulate a mask ROM version with the mask option register. In the software controlled mode, all TCR bits are read/write, except bit b3 which is write-only (always reads as a logic zero). In the MOR controlled mode, for all four devices, TCR bit b7 and b6 are read/write and bits b5, b4, b2, b1, and b0 have no effect on a write (always read as logic ones). For the MC68705R3/MC68705U3, bit b3 is write-only (reads as logic zero), and for the MC68705R5/MC68705U5, bit b3 has no effect on a write (reads as a logic one).

5.3.1 Software Controlled Mode

The TOPT (timer option) bit (b6) in the mask option register is EPROM programmed to a logic zero to select the software controlled mode, which is described first. TCR bits b5, b4, b3, b2, b1, and b0 give the program direct control of the prescaler and input select options.

The timer prescaler input frequency (fpIN) can be configured for three different operating modes plus a disable mode, depending upon the value written to TCR control bits b4 and b5 (TIE and TIN).

When the TIE and TIN bits are programmed to zero the timer input is from the internal clock (phase two) and TIMER input pin is disabled. The internal clock mode can be used for periodic interrupt generation as well as a reference for frequency and event measurement.

When TIE = 1 and TIN = 0, the internal clock and the TIMER input pin signals are ANDed to form the timer input. This mode can be used to measure external pulse widths. The external pulse simply gates in the internal clock for the duration of the pulse. The accuracy of the count in this mode is plus or minus one count.

When TIE=0 and TIN=1, no prescaler input frequency is applied to the prescaler and the timer is disabled.

When TIE and TIN are both programmed to a one, the timer is from the external clock. The external clock can be used to count external events as well as provide an external frequency for generating periodic interrupts.

Bits b0, b1, and b2 in the TCR are program controlled to choose the appropriate prescaler output. The prescaling divides the prescaler input frequency by 1, 2, 4, etc. in binary multiplex to 128 producing counter input frequency to the counter. The processor cannot write into or read from the

prescaler; however, the prescaler is set to all ones by a write operation to TCR, b3 (when bit 3 of the written data equals one), which allows for truncation-free counting.

5.3.2 MOR Controlled Mode

The MOR controlled mode of the timer is selected when the TOPT (timer option) bit (b6) in the MOR is programmed to a logic one to emulate the MC6805R2 mask-programmable prescaler and timer clock source. The timer circuits are the same as described above, however, the timer control register (TCR) is configured differently, as discussed below.

The logic level for the functions of bits b0, b1, b2, and b5 in the TCR are all determined at the time of EPROM programming. They are controlled by corresponding bits within the mask option register (MOR, \$F38). The value programmed into MOR bits b0, b1, b2, and b5 controls the prescaler division and the timer clock selection. Bit b4 (TIE) is set to a logic one in the MOR controlled mode (when read by software, these five TCR bits always read as logic ones). As in the software programmable configuration, the TIM (b6) and TIR (b7) bits of the TCR are controlled by the counter and software as described above. Bit b3 of the TCR (in the MOR controlled mode) for the MC68705R3/MC68705U3 always reads as a logic zero and can be written to a logic one to clear the prescaler; however, for the MC68705R5/MC68705U5 bit b3 is set to a logic one and when read by software always reads as a logic one. The MOR controlled mode is designed to exactly emulate the MC6805R2 which has only TIM, TIR, and PSC in the TCR and has the prescaler options defined as manufacturing mask options.

5.3.3 Timer Control Register (TCR)

The configuration of the TCR is determined by the logic level of bit 6 (timer option, TOPT) in the mask option register (MOR). Two configurations of the TCR are shown below, one for TOPT=1 and the other for TOPT=0. TOPT=1 configures the TCR to emulate the MC6805R2. When TOPT=0, it provides software control of the TCR. When TOPT=1, the prescaler "mask" options are user programmable via the MOR. A description of each TCR bit is provided below (also see Figures 5-3 and 5-4).

TCR with MOR TOPT = 1 (MC6805R2 Emulation)

| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 | _Timer Control |
|-----|-----|----|----|------|----|----|----|----------------|
| TIR | TIM | 1 | 1 | PSC* | 1 | 1 | 1 | Register \$009 |

^{*}For the MC68705R3/MC68705U3 write only, reads as a zero—for the MC68705R5/MC68705U5 reads as a one and has no effect on the prescaler.

TCR with MOR TOPT = 0 (Software Programmable Timer)

| | | | | | | | | Timer Control |
|-----|-----|-----|-----|------|-----|-----|-----|----------------|
| TIR | TIM | TIN | TIE | PSC* | PS2 | PS1 | PS0 | Register \$009 |

^{*}Write only, reads as a zero.

- b7, TIR Timer Interrupt Request Used to initiate the timer interrupt or signal a timer data register underflow when it is a logic one.
 - 1 = Set when the timer data register changes to all zeros.
 - 0= Cleared by external reset or under program control

- b6, TIM Timer Interrupt Mask Used to inhibit the timer interrupt to the processor when it is a logic one.
 - 1 = Set by an external reset or under program control.
 - 0 = Cleared under program control.
- b5, TIN External or Internal Selects the input clock source to be either the external TIMER (pin 8) or the internal phase two.
 - 1 = Selects the external clock source.
 - 0 =Selects the internal phase two (fosc \div 4) clock source.
- b4, TIE External Enable Used to enable the external TIMER (pin 8) or to enable the internal clock (if TIN = 0) regardless of the external TIMER pin state (disables gated clock feature). When TOPT = 1, TIE is always a logic one.
 - 1 = Enables external TIMER pin.
 - 0 = Disables external TIMER pin.

TIN-TIE MODES

| <u>TIN</u> | TIE | <u>CLOCK</u> |
|------------|-----|---|
| 0 | 0 | Internal Clock (phase two) |
| 0 | 1 | Gated (AND) of External and Internal Clocks |
| 1 | 0 | No Clock |
| 1 | 1 | External Clock |

- b3, PSC Prescaler Clear When TOPT=0, this is a write-only bit. It reads as a logic zero so the BSET and BCLR on the TCR function correctly. Writing a one into PSC generates a pulse which clears the prescaler. When TOPT=1, operation remains the same for the MC68705R3/MC68705U3; however, for the MC68705R5/MC68705U5 this bit is always read as a logic one and has no effect on the prescaler.
- b2, PS2 Prescaler Select These bits are decoded to select one of eight outputs on the timer preb1, PS1 scaler division resulting from decoding these bits.
- b0, PS0

| <u>PS2</u> | <u>PS1</u> | <u>PS0</u> | Prescaler Division |
|------------|------------|------------|----------------------|
| 0 | 0 | 0 | 1 (Bypass Prescaler) |
| 0 | 0 | 1 | 2 |
| 0 | 1 | 0 | 4 |
| 0 | 1 | 1 | 8 |
| 1 | 0 | 0 | 16 |
| 1 | Ò | 1 | 32 |
| 1 | 1 | 0 | 64 |
| 1 | 1 | 1 | 128 |
| | | | |

NOTE

When changing the PS2-PS0 bits in software, the PSC bit should be written to a one in the same write cycle to clear the prescaler. Changing the PS bits without clearing the prescaler may cause an extraneous toggle of the timer data register.

SECTION 6 SELF-CHECK

The self-check capability of the MC6805R2, MC6805U2, MC6805B3, and MC6805U3 microcomputers provides an internal check to determine if the part is functional. Connect the MCU as shown in Figure 6-1 and monitor the output of port C bit 3 for an oscillation of approximately 7 hertz. A 10-volt level (through a 10k resistor) on the timer input, pin 8, and pressing then releasing the RESET button, energizes the ROM-based self-check feature. The self-check program exercises the RAM, ROM, TIMER, interrupts, and I/O ports, as well as the A/D for the MC6805R2 and MC6805R3.

Several of the self-check subroutines can be called by a user program with a JSR or BSR instruction. They are the RAM, ROM, and four-channel A/D tests. The timer routine may also be called if the timer input is the internal phase two clock.

6.1 RAM SELF-CHECK SUBROUTINE

The RAM self-check is called at location \$F6F for the MC6805R2/MC6805U2 and at location \$F84 for the MC6805R3/MC6805U3. If any error is detected, it returns with the Z bit cleared; otherwise the Z bit is set. The walking diagnostic pattern method is used on the MC6805R2/U2. The MC6805R3/U3 test causes each byte to count from 0 up to 0 again with a check after each count.

The RAM test must be called with the stack pointer at \$07F. When run, the test checks every RAM cell except for \$07F and \$07E which are assumed to contain the return address.

The A and X registers and all RAM locations except \$07F and \$07E are modified.

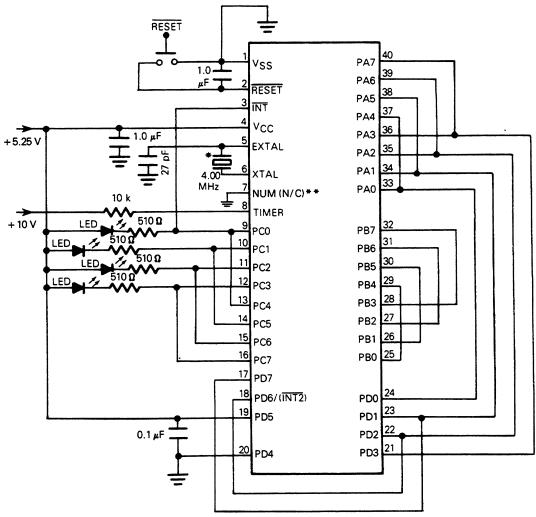
6.2 ROM CHECKSUM SUBROUTINE

The ROM self-check is called at location \$F8A for the MC6805R2/MC6805U2 and at location \$F95 for the MC6805R3/MC6805U3.

The A register should be cleared before calling the routine in the MC6805R3/MC6805U3. If any error is detected, it returns with the Z bit cleared; otherwise Z=1, X=0 on return, and A is zero if the test passes. RAM location \$040 is overwritten.

6.3 ANALOG-TO-DIGITAL CONVERTER SELF-CHECK

The analog-to-digital self-check for the MC6805R2 is called at location \$FA4 and for the MC6805R3 at \$FAE. For both devices, it returns with the Z bit cleared if any error was found; otherwise the Z bit is set.



- *This connection depends on clock oscillator user selectable mask option. Use jumper if the RC mask option is selected.

 **For the MC6805R2/MC6805U2 pin 7 is not for user application and must be connected to VSS. For the MC6805R3/MC6805U3 pin 7 is not connected.

| | | | L | ED Meanings |
|-----|---------|-------|-----|--------------------------------|
| PC0 | PC1 | PC2 | РСЗ | Remarks [1:LED ON; 0:LED OFF] |
| 1 | 0 | 1 | 0 | Bad I/O |
| 0 | 0 | 1 | 0 | Bad Timer |
| 1 | 1 | 0 | 0 | Bad RAM |
| 0 | 1 | 0 | 0 | Bad ROM |
| 1 | 0 | 0 | 0 | Bad A/D |
| 0 | 0 | 0 | 0 | Bad Interrupts or Request Flag |
| | All Fla | shing | | Good Device |

Anything else bad Part, Bad Port C, etc.

Figure 6-1. Self-Check Connections

The A and X register contents are lost. The X register must be set to four before the call. On return, X=8 and A/D channel 7 is selected. The A/D test uses the internal voltage references and confirms port connections.

6.4 TIMER SELF-CHECK SUBROUTINE

The timer self-check is called at location \$FCF for the MC6805R2/MC6805U2 and at location \$F6D for the MC6805R3/MC6805U3. If any error was found, it returns with the Z bit cleared; otherwise the Z bit is set.

In order to work correctly as a user subroutine, the internal phase two clock must be the clocking source and interrupts must be disabled. Also, on exit, the clock is running and the interrupt mask is not set so the caller must protect from interrupts if necessary.

The A and X register contents are lost. The timer self-check routine in the MC6805R2/U2 counts how many times the clock counts in 128 cycles. The number of counts should be a power of two since the prescaler is a power of two. If not, the timer probably is not counting correctly. The routine also detects a timer which is not running. In the MC6805R3/U3, this routine sets the prescaler for divide-by-128 and the timer data register is cleared. The X register is configured to count down the same as the timer data register. The two registers are then compared every 128 cycles until they both count down to zero. Any mismatch during the count down is considered an error. In the MC6805R3/U3, the A and X registers are cleared on exit from the routine.

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SECTION 7 RESET, CLOCK, AND INTERRUPT STRUCTURE

7.1 RESET

The MCU can be reset three ways: by initial powerup, by the external reset input (RESET) and by an optional internal low-voltage detect circuit (not available on the MC68705U3 or MC68705R3 EPROM versions). The RESET input consists mainly of a Schmitt trigger which senses the RESET line logic level. A typical reset Schmitt trigger hysteresis curve is shown in Figure 7-1. The Schmitt trigger provides an internal reset voltage if it senses a logical zero on the RESET pin.

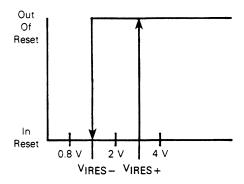


Figure 7-1. Typical Reset Schmitt Trigger Hysteresis

7.1.1 Power-On Reset (POR)

An internal reset is generated upon powerup that allows the internal clock generator to stabilize. A delay of track milliseconds is required before allowing the RESET input to go high. Refer to the power and reset timing diagram of Figure 7-2. Connecting a capacitor to the RESET input (as illustrated in Figure 7-3) typically provides sufficient delay. During powerup, the Schmitt trigger switches on (removes reset) when RESET rises to VIRES +

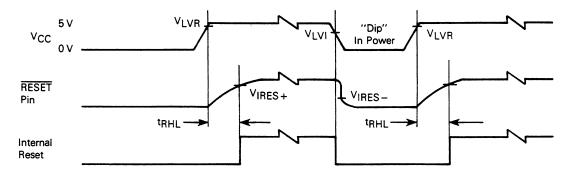


Figure 7-2. Power and Reset Timing

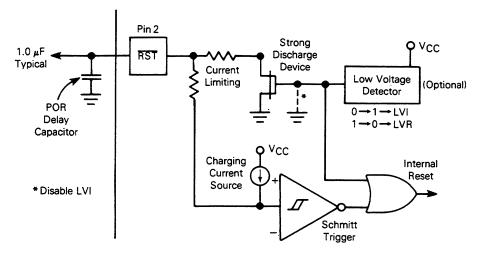


Figure 7-3. RESET Configuration

7.1.2 External Reset Input

The MCU will be reset if a logical zero is applied to the $\overline{\text{RESET}}$ input for a period longer than one machine cycle (t_{CyC}). Under this type of reset, the Schmitt trigger switches off at V_{IRES} to provide an internal reset voltage.

7.1.3 Low-Voltage Inhibit (LVI)

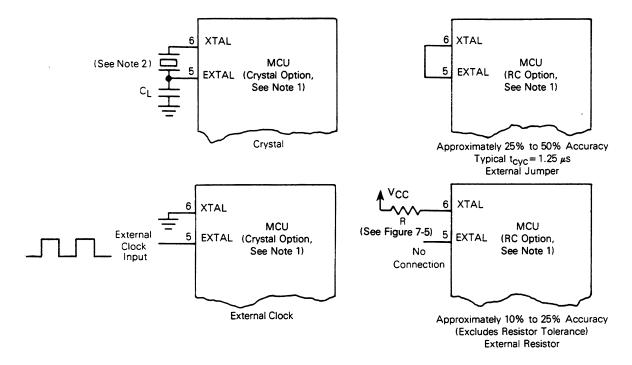
The optional low-voltage detection circuit (not available on the MC68705R3, MC68705R5, MC68705U3, and MC68705U5) causes a reset of the MCU if the power supply voltage falls below a certain level (V_{LVI}). The only requirement is that V_{CC} remains at or below the V_{LVI} threshold for one t_{CVC} minimum. In typical applications, the V_{CC} bus filter capacitor will eliminate negative-going voltage glitches of less than one t_{CVC}. The output from the low-voltage detector is connected directly to the internal reset circuitry. It also forces the RESET pin low via a strong discharge device through a resistor. The internal reset will be removed once the power supply voltage rises above a recovery level (V_{LVR}), at which time a normal power-on-reset occurs.

7.2 INTERNAL CLOCK GENERATOR OPTIONS

The internal clock generator circuit is designed to require a minimum of external components. A crystal, a resistor, a jumper wire, or an external signal may be used to generate a system clock with various stability/cost tradeoffs. The mask option register (EPROM) is programmed to select crystal or resistor operation. The oscillator frequency is internally divided by four to produce the internal system clocks. For MC6805R2, MC6805U2, MC6805R3, and MC6805U3 a manufacturing mask option is used to select crystal or resistor operation.

The different connection methods are shown in Figure 7-4. Crystal specifications and suggested PC board layouts are given in Figure 7-5. A resistor selection graph is given in Figure 7-6.

The crystal oscillator start-up time is a function of many variables: crystal parameters (especially RS), oscillator load capacitances, IC parameters, ambient temperature, and supply voltage. To ensure rapid oscillator start up, neither the crystal characteristics nor the load capacitances should exceed recommendations.



NOTES:

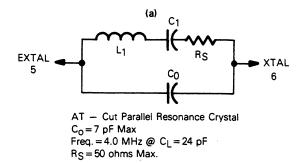
- For the MC68705R3, MC68705U3, MC68705R5, and MC68705U5 MOR b7 = 0 for the crystal option and MOR b7 = 1 for the RC option. When the TIMER input pin is in the V_{IHTP} range (in the bootstrap EPROM programming mode), the crystal option is forced. When the TIMER input is at or below V_{CC}, the clock generator option is determined by bit 7 of the Mask Option Register (CLK).
- 2. The recommended C_L value with a 4.0 MHz crystal is 27 pF maximum, including system distributed capacitance. There is an internal capacitance of approximately 25 pF on the XTAL pin. For crystal frequencies other than 4 MHz, the total capacitance on each pin should be scaled as the inverse of the frequency ratio. For example, with a 2 MHz crystal, use approximately 50 pF on EXTAL and approximately 25 pF on XTAL. The exact value depends on the Motional-Arm parameters of the crystal used.

Figure 7-4. Clock Generator Options

When utilizing the on-board oscillator, the MCU should remain in a reset condition (reset pin voltage below VIRES+) until the oscillator has stabilized at its operating frequency. Several factors are involved in calculating the external reset capacitor required to satisfy this condition: the oscillator start-up voltage, the oscillator stabilization time, the minimum VIRES+, and the reset charging current specification.

Once VCC minimum is reached, the external \overline{RESET} capacitor will begin to charge at a rate dependent on the capacitor value. The charging current is supplied from VCC through a large resistor, so it appears almost like a constant current source until the reset voltage rises above VIRES+. Therefore, the \overline{RESET} pin will charge at approximately:

Assuming the external capacitor is initially discharged.



Piezoelectric ceramic resonators which have the equivalent specifications may be used instead of crystal oscillators. Follow ceramic resonator manufacturer's suggestions for C_0 , C_1 , and R_S values.

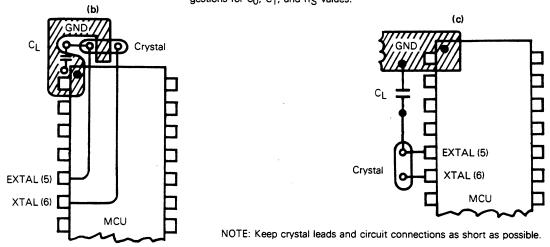


Figure 7-5. Crystal Motional-Arm Parameters and Suggested PC Board Layout

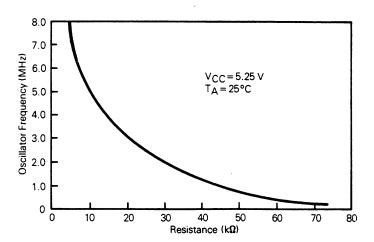


Figure 7-6. Typical Frequency Selection for Resistor (RC Oscillator Option)

7.3 INTERRUPTS

The microcomputers can be interrupted four different ways: through the external interrupt (INT) input pin, the internal timer interrupt request, the external port D bit 6 (INT2) input pin, or the software interrupt instruction (SWI). When any interrupt occurs: the current instruction (including SWI) is completed, processing is suspended, the present CPU state is pushed onto the stack, the interrupt bit (I) in the condition code register is set, the address of the interrupt routine is obtained from the appropriate interrupt vector address, and the interrupt routine is executed. Stacking the CPU register, setting the I bit, and vector fetching require a total of 11 t_{CYC} periods for completion. A flowchart of the interrupt sequence is shown in Figure 7-7. The interrupt service routine must end with a return from interrupt (RTI) instruction which allows the MCU to resume processing of the

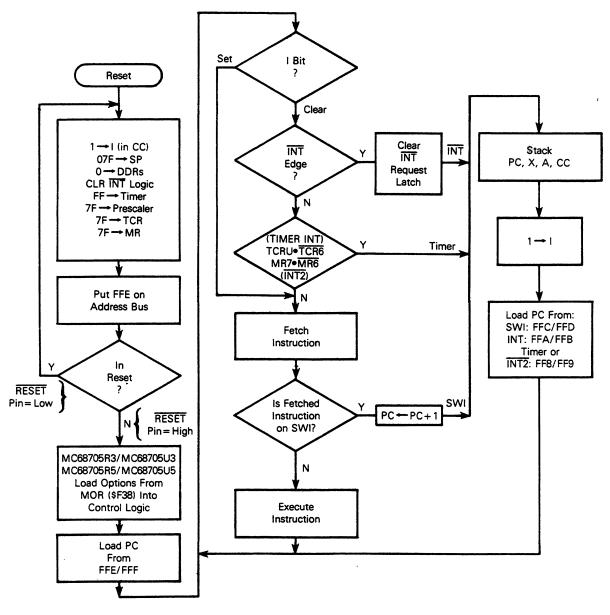


Figure 7-7. Reset and Interrupt Processing Flowchart

program prior to the interrupt (by unstacking the previous CPU state). Unlike RESET, hardware interrupts do not cause the current instruction execution to be halted, but are considered pending until the current instruction execution is complete.

When the current instruction is complete, the processor checks all pending hardware interrupts and if unmasked, proceeds with interrupt processing; otherwise the next instruction is fetched and executed. Note that masked interrupts are latched for later interrupt service.

If both an external interrupt and a timer interrupt are pending at the end of an instruction execution, the external interrupt is serviced first. The SWI is executed as any other instruction.

NOTE

The timer and INT2 interrupts share the same vector address. The interrupt routine must determine the source by examining the interrupt request bits (TCR b7 and MR b7). Both TCR b7 and MR b7 can only be written to zero by software.

The external interrupt, $\overline{\text{INT}}$ and $\overline{\text{INT2}}$, are synchronized and then latched on the falling edge of the input signal. The $\overline{\text{INT2}}$ interrupt has an interrupt request bit (bit 7) and a mask bit (bit 6) located in the miscellaneous register (MR). The $\overline{\text{INT2}}$ interrupt is inhibited when the mask bit is set. The $\overline{\text{INT2}}$ is always read as a digital input on port D. The $\overline{\text{INT2}}$ and timer interrupt request bits, if set, cause the MCU to process an interrupt when the condition code I bit is clear.

A sinusoidal input signal (fINT maximum) can be used to generate an external interrupt for use as a zero-crossing detector. This allows applications such as servicing time-of-day routines and engaging/disengaging ac power control devices. Off-chip full wave rectification provides an interrupt at every zero crossing of the ac signal and thereby provides a 2f clock. See Figure 7-8.

A software interrupt (SWI) is an executable instruction which is executed regardless of the state of the I bit in the condition code register. SWIs are usually used as breakpoints for debugging or as system calls.

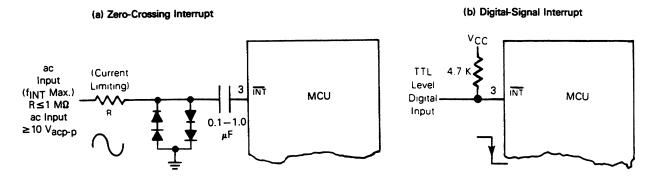
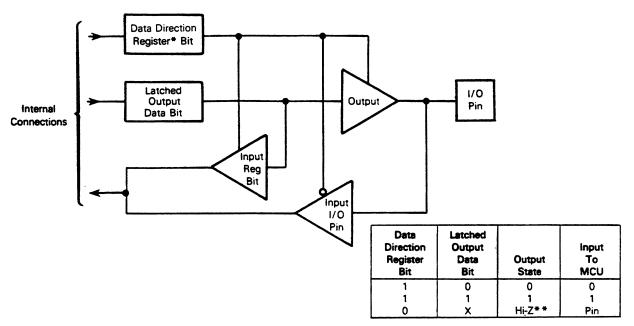


Figure 7-8. Typical Interrupt Circuits

SECTION 8 INPUT/OUTPUT CIRCUITRY AND ANALOG-TO-DIGITAL CONVERTER

8.1 INPUT/OUTPUT CIRCUITRY

There are 32 input/output pins. The INT pin may be polled with branch instructions to provide an additional input pin. All pins on ports A, B, and C are programmable as either inputs or outputs under software control of the corresponding data direction register (DDR). The port I/O programming is accomplished by writing the corresponding bit in the port DDR to a logic one for output or a logic zero for input. On reset all the DDRs are initialized to a logic zero state, placing the ports in the input mode. The port output registers are not initialized on reset and should be initialized by software before changing the DDRs from input to output. A read operation on a port programmed as an output will read the contents of the output latch regardless of the logic levels at the output pin, due to output loading. Refer to Figure 8-1.



^{*}DDR is a write-only register and reads as all ones.

Figure 8-1. Typical Port I/O Circuitry

^{**}Port B and C are three-state ports. Port A has optional internal pullup devices to provide CMOS data drive capability. See SECTION 11 ELECTRICAL CHARACTERISTICS.

All input/output lines are TTL compatible as both inputs and outputs. Port A lines are CMOS compatible as outputs (mask option on the MC6805R2, MC6805U2, MC6805R3, and MC6805U3) while port B, C, and D lines are CMOS compatible as inputs. Port D lines are input only; thus, there is no corresponding DDR. When programmed as outputs, port b is capable of sinking 10 milliamperes and sourcing 1 milliampere on each pin.

Port D provides the reference voltage, $\overline{\text{INT2}}$, and multiplexed analog inputs for the MC6805R2, MC6805R3, MC68705R3, and MC68705R5. All of these lines are shared with the port D digital inputs. Port D may always be used as digital inputs and may also be used as analog inputs providing VRH and VRL are connected to the appropriate reference voltages. The VRL and VRH lines (PD4 and PD5) are internally connected to the A/D resistor. Analog inputs may be prescaled to attain the VRL and VRH recommended input voltage range.

The address maps in Section 3 give the addresses of data registers and data direction registers. The register configuration is provided in Figure 7-6. Figure 8-2 provides some examples of port connections.

CAUTION

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006). A read operation on these registers is undefined. Since BSET and BCLR are read-modfly-write in function, they cannot be used to set or clear a single DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port be written using a single-store instruction.

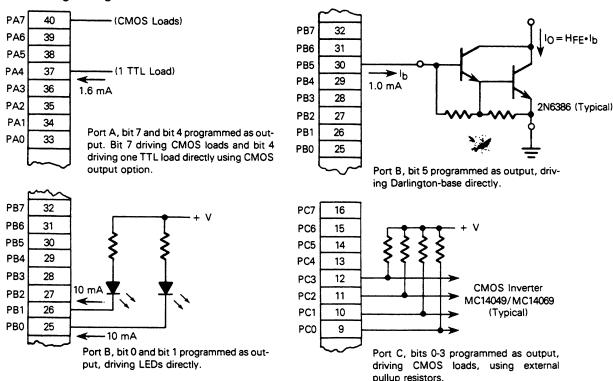


Figure 8-2a. Typical Port Connections—Output Modes

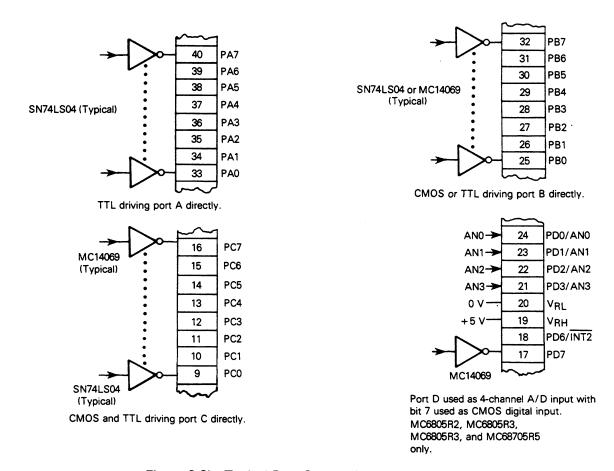


Figure 8-2b. Typical Port Connections—Input Modes

The latched output data bit (see Figure 8-1) must always be written. Therefore, any write to a port writes all of its data bits even though the port DDR is set to input. This may be used to initialize the data register and avoid undefined outputs; however, care must be exercised when using read-modify-write instructions, since the data read corresponds to the pin level if the DDR is an input (zero) and corresponds to the latched output data when the DDR is an output (one).

8.2 ANALOG-TO-DIGITAL CONVERTER

The MC6805R2, MC6805R3, MC68705R3 and MC68705R5 microcomputers have an 8-bit analog-to-digital (A/D) converter implemented on the chip using a successive approximation technique, as shown in Figure 8-3. Up to four external analog inputs, via port D, are connected to the A/D through a multiplexer. Four internal analog channels may be selected for calibration purposes (VRH-VRL, VRH-VRL/2, VRH-VRL/4, and VRL). The accuracy of these internal channels will not necessarily meet the accuracy specifications of the external channels.

The multiplexer selection is controlled by the A/D control register (ACR) bits 0, 1, and 2; see Table 8-1. This register is cleared during any reset condition. Refer to Figure 7-6 for the register configuration.

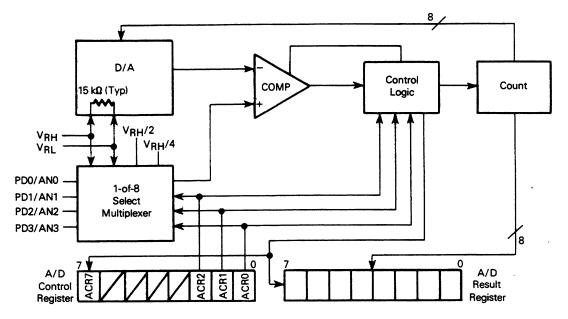


Figure 8-3. A/D Block Diagram

Table 8-1. A/D Input MUX Selection

| A/D | Control Re | gister | Input Selected | A/D | Output (F | lex) |
|------|------------|--------|-------------------|-----|-----------|------|
| ACR2 | ACR1 | ACR0 | Iliput Selected | Min | Тур | Max |
| 0 | 0 | 0 | AN0 | | | |
| 0 | 0 | 1 | AN1 | | | |
| 0 | 1 | 0 | AN2 | | | |
| 0 | 1 | 1 | AN3 | | | |
| 1 | 0 | 0 | V _{RH} * | FE | FF | FF |
| 1 | 0 | 1 | V _{RL} * | 00 | 00 | 01 |
| 1 | 1 | 0 | VRH/4* | 3F | 40 | 41 |
| 1 | 1 | 1 | VRH/2* | 7F | 80 | 81 |

^{*}Internal (Calibration) Levels

Whenever the ACR is written, the conversion in progress is aborted, the conversion complete flag (ACR bit 7) is cleared, and the selected input is sampled for five machine cycles and held internally. During these five cycles, the analog input will appear approximately like a 25 picofarad (maximum) capacitor (plus approximately 10 pF for packaging) charging through a 2.6 kilohm resistor (typical). Refer to Figure 8-4.

The converter operates continuously using 30 machine cycles to complete a conversion of the sampled analog input. When the conversion is complete, the digitized sample of digital value is placed in the A/D result register (ARR), the conversion complete flag is set, the selected input is sampled again, and a new conversion is started.

The A/D is ratiometric. Two reference voltages (VRH and VRL) are supplied to the converter via port D pins. An input voltage equal to VRH converts to \$FF (full scale) and an input voltage equal to VRL converts to \$00. An input voltage greater than VRH converts to \$FF and no overflow indication is provided. Similarly, an input voltage less than VRL, but greater than VSS converts to \$00. Maximum and minimum ratings must not be exceeded. For ratiometric conversion, the source of each analog input should use VRH as the supply voltage and be referenced to VRL. To maintain the full

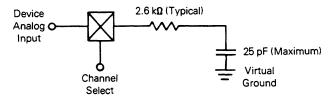


Figure 8-4. Effective Analog Input Inpedance (During Sampling Only)

accuracy on the A/D, V_{RH} should be equal to or less than V_{DD} , V_{RL} should be equal to or greater than V_{SS} but less than the maximum specification and $(V_{RH}-V_{RL})$ should be equal to or greater than 4 volts.

The A/D has a built-in $\frac{1}{2}$ LSB offset intended to reduce the magnitude of the quantizing error to $\pm \frac{1}{2}$ LSB, rather than ± 0 , ± 1 LSB with no offset. This implies that, ignoring errors, the transition point from \$00 to \$01 occurs at $\frac{1}{2}$ LSB above V_{RL}. Similarly, the transition from \$FE to \$FF occurs 1 $\frac{1}{2}$ LSB below V_{RH}, ideally. Refer to Figures 8-5 and 8-6.

On release of reset, the A/D control register (ACR) is cleared therefore after reset, channel zero will be selected and the conversion complete flag will be clear.

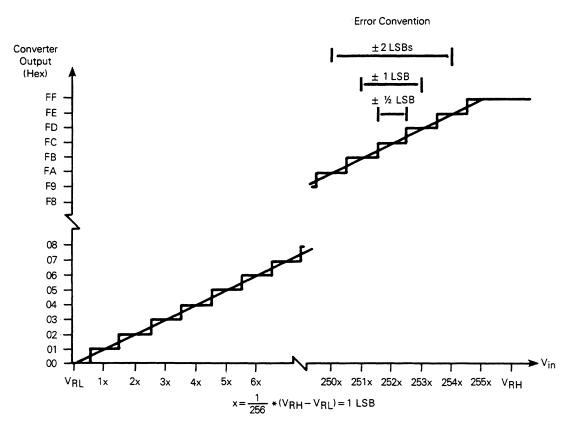
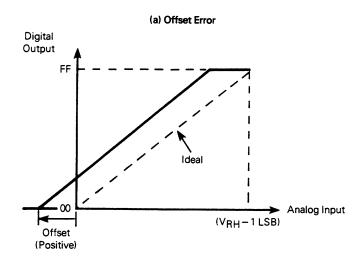
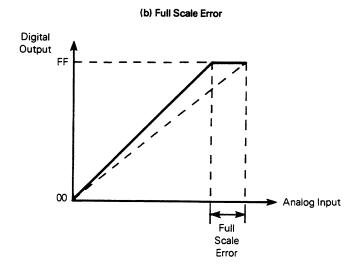


Figure 8-5. Ideal Converter Transfer Characteristic





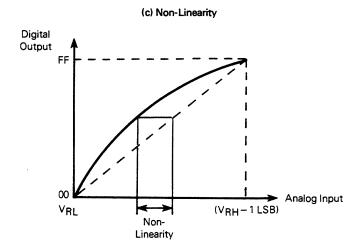


Figure 8-6. Types of Conversion Errors

SECTION 9 MASK OPTIONS AND PROGRAMMING

The information in this section pertains only to the MC68705R3, MC68705U3, MC68705R5, and MC68705U5 EPROM versions of the M6805 Family.

9.1 MASK OPTIONS

The MC68705R3, MC68705U3, MC68705R5, and MC68705U5 mask option registers are implemented in EPROM. Like all other EPROM bytes, the MOR contains all zeros prior to programming (if erased).

When used to emulate the MC6805R2 and MC6805U2, five of the eight MOR bits are used in conjunction with the prescaler. Of the remaining, the b7 bit is used to select the type of clock oscillator, b3 is the secure/non-secure mode option for the MC68705R5/MC68705U5 only (b3 is not used by the MC68705R3/MC68705U3), and b4 is not used. Bits b0, b1, and b2 determine the division of the timer prescaler. Bit b6 determines the timer option selection. The value of the TOPT bit (b6) is programmed to configure the TCR (a logic one for MC6805R2/MC6805U2 emulation).

If the MOR timer option (TOPT) bit is a zero, the MC6805R3 and MC6805U3 are emulated. Here, bits b5, b4, b2, b1, and b0 set the initial value of their respective TCR bits during reset. After initialization the TCR is software controllable.

A description of the MOR bits is as follows:

| b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 | _Mask Option |
|-----|------|-----|----|------|----|----|----|----------------|
| CLK | TOPT | CLS | | SNM* | P2 | P1 | P0 | Register \$F38 |

^{*}MC68705R5 and MC68705U5 only.

b7, CLK Clock Oscillator Type

1 = RC

0 = Crystal

NOTE

VIHTP on the TIMER (pin 8) forces the crystal mode.

b6, TOPT Timer Option

- 1 = MC6805R2/MC6805U2 type timer/prescaler. All bits, except b6 and b7, of the timer control register (TCR) are invisible to the user. Bits b5, b2, b1, and b0 of the mask option register determine the equivalent MC6805R2/MC6805U2 mask options.
- 0 = MC6805R3/MC6805U3 type timer/prescaler. All TCR bits are implemented as a software programmable timer. The state of bits b5, b4, b2, b1, and b0 set the initial values of their respective TCR bits (TCR is then software controlled after initialization).

- b5, CLS Timer/Prescaler Clock Source 1 = External TIMER pin. 0 = Intenal phase two.
- b4 Not used if MOR TOPT = 1 (MC6805R2/MC6805U2 emulation). Sets initial value of TCR TIE if MOR TOPT = 0 (MC6805R3/MC6805U3 emulation).
- b3, SNM* When this bit is set, i.e., programmed to a one, it is not possible to access the EPROM contents of the MC68705R5 and MC68705U5 externally. For more information refer to 9.4 PROGRAMMING FIRMWARE.

Note, For MC68705R3 and MC68705U3 operation, b3 is not used.

b2, P2 Prescaler Option — the logic levels of these bits, when decoded, select one of eight outb1, P1 puts on the timer prescaler. The table below shows the division resulting from decoding b0, P0 combinations of these three bits.

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Two examples for programming the mask option register are discussed below.

Example 1

To emulate an MC6805R2/MC6805U2 to verify your program with an RC oscillator and an event count input for the timer with no prescaling, the mask option register would be set to 11110000. To write the mask option register, it is simply programmed as any other EPROM byte.

Example 2

Suppose you wish to use programmable prescaler functions (MC6805R3/MC6805U3 emulation), and you wish the initial condition of the prescaler to be divided by 64, with the input disabled and an internal clock source. If the clock oscillator was to be in the crystal mode, the mask option register would be set to 00000110.

9.2 ON-CHIP PROGRAMMING HARDWARE

The programming control register (PCR) at location \$00B is an 8-bit register which utilizes the three least significant bits (the five most significant bits are set to logic ones). This register provides the

^{*}MC68705R5 and MC68705U5 only.

necessary control bits to allow programming the EPROM. The bootstrap program manipulates the PCR when programming so that users need not be concerned with the PCR in most applications. A description of each bit follows.

| | b7 | b6 | b5 | b4 | b3 | b2 | b1 | b0 | Programming |
|---|----|----|----|----|----|------|-----|-----|----------------|
| | 1 | 1 | 1 | 1 | 1 | VPON | PGE | PLE | Control |
| • | | | | | | | | | Register \$00B |

b0, PLE Programming Latch Enable — When cleared, this bit allows the address and data to be latched into the EPROM. When this bit is set, data can be read from the EPROM.

1 = (set) read EPROM

0=(clear) latch address and data into EPROM (read disable)

PLE is set during a reset, but may be cleared any time. However, its effect on the EPROM is inhibited if $\overline{\text{VPON}}$ is a logic one.

b1, PGE Program Enable — When cleared, PGE enables programming of the EPROM. PGE can only be cleared if PLE is cleared. PGE must be set when changing the address and data; i.e., setting up the byte to be programmed.

1 = (set) inhibit EPROM programming

0=(clear) enable EPROM programming (if PLE is low)

PGE is set during a reset; however, it has no effect on EPROM circuits if VPON is a logic one.

b2, VPON (VPP ON) — VPON is a read-only bit and when at a logic zero it indicates that a "high voltage" is present at the VPP pin.

1 = no "high voltage" on Vpp pin

0="high voltage" on VPP pin

VPON being one "disconnects" PGE and PLE from the rest of the chip, preventing accidental clearing of these bits from affecting the normal operating mode.

NOTE

VPON being zero does not indicate that the Vpp level is correct for programming. It is used as a safety interlock for the user in the normal operating mode.

The programming control register functions are shown below.

| VPON | PGE | PLE | Programming Conditions |
|-------------|-----|-----|--|
| 0 | 0 | 0 | Programming mode (program EPROM byte) |
| 1 | 0 | 0 | PGE and PLE disabled from system |
| 0 | 1 | 0 | Programming disabled (latch address and data in EPROM) |
| 1 | 1 | 0 | PGE and PLE disabled from system |
| 0 | 0 | 1 | Invalid state; PGE=0 iff PLE=0 |
| 1 | 0 | 1 | Invalid state; PGE=0 iff PLE=0 |
| 0 | 1 | 1 | "High voltage" on VPP |
| 1 | 1 | 1 | PGE and PLE disabled from system (operating mode) |

9.3 ERASING THE EPROM

The EPROM can be erased by exposure to high-intensity ultraviolet (UV) light with a wavelength of 2537 angstroms. The recommended integrated dose (UV intensity × exposure time) is 25 Ws/cm². The lamps should be used without shortwave filters and the EPROM should be positioned about one inch from the UV tubes. Ultraviolet erasure clears all bits of the EPROM to the zero state. Data is the entered by programming ones into the desired bit locations.

CAUTION

Be sure that the EPROM window is shielded from light except when erasing. This protects both the EPROM and light-sensitive nodes.

9.4 PROGRAMMING FIRMWARE

The MC68705R3, MC68705U3, MC68705R5, and MC68705U5 have 120 bytes of mask ROM containing a bootstrap program which can be used to program the EPROM. The vector at addresses \$FF6 and \$FF7 is used to start executing the program. This vector is fetched when VIHTP is applied to pin 8 (TIMER pin) and the RESET pin is allowed to rise above VIRES+. Figure 9-1 provides a schematic diagram of a circuit and a summary of programming steps which can be used to program the EPROM. It is possible to program the EPROM via the bootstrap software and validate its contents in the secure mode. The only way to go from the secure mode to the non-secure mode is by erasing the entire EPROM.

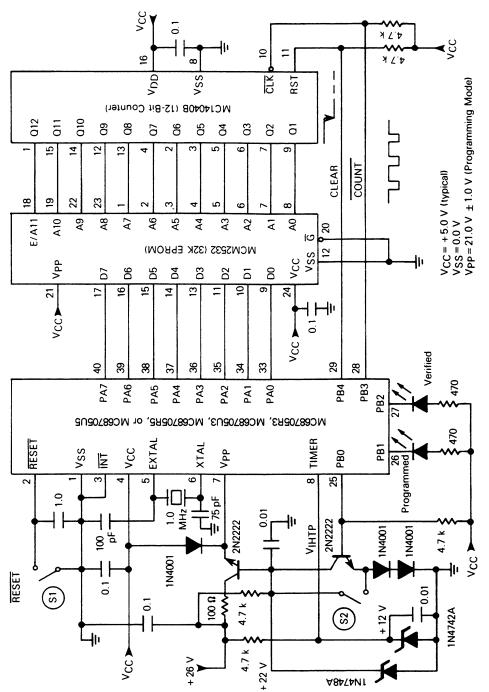
9.5 PROGRAMMING STEPS

The MCM2532 UV EPROM must first be programmed with an exact duplicate of the information that is to be transferred to the MC68705R3, MC68705U3, MC68705R5, or MC68705U5. Non-EPROM addresses are ignored by the bootstrap. Since the MC68705R3, MC68705U3, MC68705R5, or MC68705U5 and the MCM2532 are to be inserted and removed from the circuit, they should be mounted in sockets. In addition, the precaution below must be observed (refer to Figure 9-1).

CAUTION

Be sure S1 and S2 are closed and VCC and \pm 26 V are not applied when inserting the MC68705R3, MC68705U3, MC68705R5, or MC68705U5 and MCM2532 into their respective sockets. This ensures that $\overline{\text{RESET}}$ is held low while inserting the devices.

When ready to program the MC68705R3, MC68705U3, MC68705R5, or MC68705U5 it is only necessary to provide V_{CC} and + 26 volts, open switch S2 (to apply V_{PP} and V_{IHTP}), and then open S1 (to remove reset). Once the voltages are applied and both S2 and S1 are open, the CLEAR output control line (PB4) goes high and then low, then the 12-bit counter (MC14040B) is clocked by the PB3 output (COUNT). The counter selects the MCM2532 EPROM byte which is to load the equivalent EPROM byte selected by the bootstrap program. Once the EPROM location is loaded, COUNT clocks the counter to the next EPROM location. This continues until the EPROM is completely programmed at which time the programmed indicator LED is lit. The counter is cleared and the loop is repeated to verify the programmed data. The verified indicator LED lights if the programming is correct.



Summary of Programming Steps:
1. When plugging in the MC68705R3, MC68705U3, MC68705R5, or MC68705U5 or the MCM2532 be sure that S1 and S2 are closed and that V_{CC} and +26 V are not applied.

2. To initiate programming, be sure S1 is closed, S2 is closed and V_{CC} and +25 V are applied. Then open S2, followed by S1. 3. Before removing the MC68705R3, MC68705R5, or MC68705U5, first close S2 and then close S1. Disconnect V_{CC} and +26 V then remove the MC68705R3, MC68705U3, MC68705R5, or MC68705U5.

Figure 9-1. Programming Connections Schematic Diagram

Once the EPROM has been programmed and verified, close switch S2 (to remove VPP and VIHTP) and close switch S1 (to reset). Disconnect +26 volts and VCC, then remove the EPROM from its socket.

9.6 EMULATION

The MC68705R3 and MC68705R5 emulate the MC6805R2 and MC6805R3 while the MC68705U3 and MC68705U5 emulate the MC685U2 and MC6805U3 "exactly." MC6805R2, MC6805U2, MC6805R3, and MC6805U3 mask features are implemented in the mask option register (MOR) EPROM byte. There are a few minor exceptions to the exactness of emulation which are listed below.

- The MC6805R2/MC6805U2 and MC6805R3/MC6805U3 "future ROM" areas are implemented in the MC68705R3/MC68705U3 and MC68705R5/MC68705U5 and these 1728 bytes must be left unprogrammed to accurately simulate the MC6805R2/MC6805U2 and MC6805R3/MC6805U3. (The MC6805R2/MC6805U2 and MC6805R3/MC6805U3 read all zeros from this area.)
- 2. The reserved ROM areas have different data stored in them and this data is subject to change without notice. The MC6805R2, MC6805U2, MC6805R3, and MC6805U3 use the reserved ROM for the self-check feature while the MC68705R3, MC68705U3, MC68705R5, and MC68705U5 use this area for the bootstrap program.
- 3. The MC6805R2/MC6805U2 and MC6805R3/MC6805U3 read all ones in their 48 byte "future RAM" area. This RAM is not implemented in the MC6805R2/MC6805U2 and MC6805R3/MC6805U3 mask ROM version, but is implemented in the EPROM version (MC68705R3/MC68705U3 and MC68705R5/MC68705U5).
- 4. The Vpp line (pin 7) in the MC68705R3/MC68705U3 and MC68705R5/MC68705U5 EPROM versions is tied to VCC for normal operation. In the MC6805R2/MC6805U2 and MC6805R3/MC6805U3 mask ROM versions, pin 7 is grounded in normal operation.
- 5. The LVI feature is not available in the EPROM version.
- 6. The MC68705R3/MC68705U3 and MC68705R5/MC68705U5 EPROM versions do not function in the MEX6805 Support System. In normal operation, all pin functions are the same as on the MC6805R2/MC6805U2 and MC6805R3/MC6805U3 mask ROM versions, except for pin 7 as previously noted.

The operation of all other circuitry has been exactly duplicated or designed to function exactly the same way in all devices including interrupts, timer, data ports, and data direction registers (DDRs).

SECTION 10 SOFTWARE

10.1 BIT MANIPULATION

The microcomputers have the ability to set or clear any single RAM or I/O bit (except the data direction registers) with a single instruction (BSET, BCLR) (see Caution below). Any bit in page zero can be tested using the BRSET and BRCLR instructions and the program branches as a result of its state. The carry bit equals the value of the bit references by BRSET or BRCLR. The capability of working with any bit in RAM, ROM, or I/O allows the user to have individual flags in RAM or to handle single I/O bits as control lines.

CAUTION

The corresponding data direction registers for ports A, B, and C are write-only registers (locations \$004, \$005, and \$006). A read operation on these registers is undefined. Since BSET and BCLR are read-modify-write functions, they cannot be used to set a data direction register bit (all "unaffected" bits would be set). It is recommended that all data direction register bits in a port be written using a single-store instruction.

The coding examples shown in Figure 10-1 illustrate the usefulness of the bit manipulation and test instruction. Assume that the microcomputer is to communicate with an external serial device. The external device has a data ready signal, a data output line, and a clock line to clock data one bit at a time, least significant bit first out of the device. The microcomputer waits until the data is ready, clocks the external device, picks up the data in the carry flag, clears the clock line, and finally accumulates the data bit in a random-access memory location.

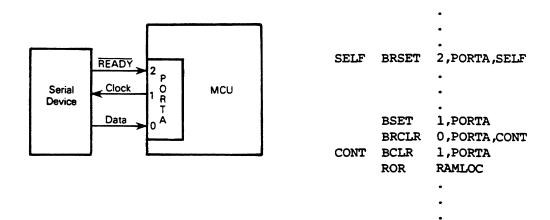


Figure 10-1. Bit Manipulation Examples

10.2 ADDRESSING MODES

The microcomputers have ten addressing modes available for use by the programmer. They are explained briefly in the following paragraphs. For additional details and illustrations, refer to the M6805 HMOS/M146805 CMOS Family Microcomputer/Microprocessor User's Manual.

The term "effective address" (EA) is used in describing the addressing modes. EA is defined as the address from which the argument for an instruction is fetched or stored.

10.2.1 Immediate

In the immediate addressing mode, the operand is contained in the byte immediately following the opcode. The immediate addressing mode is used to access constants which do not change during program execution (e.g., a constant used to initialize a loop counter).

10.2.2 Direct

In the direct addressing mode, the effective address of the argument is contained in a single byte following the opcode byte. Direct addressing allows the user to directly address the lowest 256 bytes in memory with a single two-byte instruction. This address area includes all on-chip RAM and I/O registers and 128 bytes of ROM. Direct addressing is an effective use of both memory and time.

10.2.3 Extended

In the extended addressing mode, the effective address of the argument is contained in the two bytes following the opcode. Instructions with extended addressing modes are capable of referencing arguments anywhere in memory with a single three-byte instruction. When using the Motorola assembler, the user need not specify whether an instruction uses direct or extended addressing. The assembler automatically selects the shortest form of the instruction.

10.2.4 Relative

The relative addressing mode is only used in branch instructions. In relative addressing, the contents of the 8-bit signed byte (the offset) following the opcode is added to the PC if, and only if, the branch condition is true. Otherwise, control proceeds to the next instruction. The span of relative addressing is from -126 to +129 from the opcode address. The programmer need not worry about calculating the correct offset if he uses the Motorola assembler, since it calculates the proper offset and checks to see if it is within the span of the branch.

10.2.5 Indexed, No Offset

In the indexed, no offset addressing mode, the effective address of the argument is contained in the 8-bit index register. Thus, this addressing mode can access the first 256 memory locations. These instructions are only on byte long. This mode is often used to move a pointer through a table or to hold the address of a frequently referenced RAM or I/O location.

10.2.6 Indexed, 8-Bit Offset

In the indexed, 8-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the unsigned byte following the opcode. This addressing mode is

useful in selecting the kth element in an n element table. With this two-byte instruction, k would typically be in X with the address of the beginning of the table in the instruction. As such, tables may begin anywhere within the first 256 addressable locations and could extend as far as location 510 (\$1FE is the last location at which the instruction may begin).

10.2.7 Index, 16-Bit Offset

In the indexed, 16-bit offset addressing mode, the effective address is the sum of the contents of the unsigned 8-bit index register and the two unsigned bytes following the opcode. This addressing mode can be used in a manner similar to indexed, 8-bit offset except that this three-byte instruction allows tables to be anywhere in memory. As with direct and extended, the Motorola determines the shortest form of indexed addressing.

10.2.8 Bit Set/Clear

In the bit set/clear addressing mode, the bit to be set or cleared is part of the opcode, and the byte following the opcode specifies the direct addressing of the byte in which the specified bit is to be set or cleared. Thus, any read/write bit in the first 256 locations of memory, including I/O, can be selectively set or cleared with a single two-byte instruction.

CAUTION

The corresponding DDRs for ports A, B, and C are write-only registers (registers at \$004, \$005, and \$006). A read operation on these registers is undefined since BSET and BCLR are read-modify-write in function, they cannot be used to set or clear a single DDR bit (all "unaffected" bits would be set). It is recommended that all DDR bits in a port must be written using a single-store instruction.

10.2.9 Bit Test and Branch

The bit test and branch addressing mode is a combination of direct addressing and relative addressing. The bit which is to be tested and condition (set or clear) is included in the opcode, and the address of the byte to be tested is in the single byte immediately following the opcode byte. The signed relative 8-bit offset in the third byte is added to the PC if the specified bit is set or cleared in the specified memory location. This single three-byte instruction allows the program to branch based on the condition of any readable bit in the first 256 locations of memory. The span of branching is from -125 to +130 from the opcode address. The state of the tested bit is also transferred to the carry bit of the condition code registers. See Caution under paragraph 10.2.8.

10.2.10 Inherent

In the inherent addressing mode, all the information necessary to execute the instruction is contained in the opcode. Operations specifying only the index register or accumulator, as well as control instruction with no other agruments, are included in this mode. These instructions are one byte long.

10.3 INSTRUCTION SET

The MCU has a set of 59 basic instructions, which when combined with the 10 addressing modes produce 207 usable opcodes. They can be divided into five types: register/memory, read-modify-write, branch, bit manipulation, and control. The following paragraphs briefly explain each type. All the instructions within a given type are presented in individual tables.

10.3.1 Register/Memory Instructions

Most of these instructions use two operands. One operand is either the accumulator or the index register. The other operand is obtained from meory using one of the addressing modes. The jump unconditional (JMP) and jump to subroutine (JSR) instructions have no register operand. Refer to Table 10-1.

10.3.2 Read-Modify-Write Instructions

These instructions read a memory location or a register, modify or test its contents, and write the modified value back to memory or to the register (see Caution under paragraph 10.2.8). The test for negative or zero (TST) instructions is included in the read-modify-write instructions, though it does not perform the write. Refer to Table 10-2.

10.3.3 Branch Instructions

The branch instructions cause a branch from the program when a certain condition is met. Refer to Table 10-3.

10.3.4 Bit Manipulation Instructions

These instructions are used on any bit in the first 256 bytes of memory; see Caution under paragraph 10.2.8. One group either sets or clears. The other group performs the bit test and branch operations. Refer to Table 10-4.

10.3.5 Control Instructions

The control instructions control the MCU operations during program execution. Refer to Table 10-5.

10.3.6 Alphabetical Listing

The complete instruction set is given in alphabetical order in Table 10-6.

10.3.7 Opcode Map Summary

Table 10-7 is an opcode made for the instructions used on the MCU.

Table 10-1. Register Memory Instructions

| | | | | | | | | | Adk | Addressing Modes | Mode | 2 | | | | | | |
|----------------------------------|----------|------|-----------|----------|------|--------|--------|--------|----------|------------------|----------------|--------------|----------|----------------|-----------|---------|-----------------|----------|
| | | | | | | | | | | | ٤ | Indexed | - | Indexed | bex | _ | Indexed | Pe |
| | | 드 | Immediate | 8 | _ | Direct | | ப | Extended | | N _O | (No Offset) | | (8-Bit Offset) | Offset) | | (16-Bit Offset) | ffset) |
| | | g | ** | | | | ## | | ## | ** | | # | do , | | ** | | | # |
| Function | Mnemonic | Code | Bytes | Cycles (| Code | Bytes | Cycles | Code | Bytes | Cycles | Code | Bytes Cycles | les Code | de Bytes | es Cycles | es Code | e Bytes | s Cycles |
| Load A from Memory | LDA | 9V | 2 | 2 | 98 | 2 | 4 | ဗ | 3 | 5 | F6 | 1 4 |) E6 | 5 2 | 5 | 90 | 3 | 9 |
| Load X from Memory | ΧQ٦ | AE | 2 | 2 | BE | 2 | 4 | CE | 3 | 5 | FE | 1 4 |) EE | E 2 | 5 | DE | 3 | 9 |
| Store A in Memory | STA | | 1 | - | 87 | 2 | 2 | C2 | 3 | 9 | F7 | 1 5 | ; E7 | 7 2 | 9 | D7 | 3 | 7 |
| Store X in Memory | STX | 1 | - | ı | ВF | 2 | 2 | CF | 3 | 9 | FF | 1 5 | EF. | F 2 | 9 | DF | 3 | 7 |
| Add Memory to A | ADD | AB | 2 | 2 | 88 | 2 | 4 | CB | 3 | 9 | FB | 1 4 | EB | 3 2 | 2 | DB | 3 | 9 |
| Add Memory and Carry to A | ADC | 6Y | 2 | 2 | B3 | 2 | 4 | හ | 3 | 5 | F9 | 1 4 | E9 | 9 2 | 2 | 60 | 3 | 9 |
| Subtract Memory | SUB | 9Α | 2 | 2 | B0 | 2 | 4 | တ | 3 | 2 | F0 | 1 4 | E0 | 0 2 | 2 | 00 | 3 | 9 |
| Subtract Memory from A | | | | | | | | | | | | | | | | | | |
| with Borrow | SBC | A2 | 2 | 2 | 82 | 2 | 4 | C | 3 | 5 | F2 | 1 4 | 1 E2 | 2 2 | 2 | D2 | 3 | 9 |
| AND Memory to A | AND | A4 | 2 | 2 | 84 | 2 | 4 | 2 | 3 | 2 | F4 | 1 4 | E4 | 4 2 | 2 | 2 | က | 9 |
| OR Memory with A | ORA | ΑA | 2 | 2 | ВА | 2 | 4 | CA | 3 | 5 | FA | 1 4 | EA | 4 2 | 2 | DA | 3 | 9 |
| Exclusive OR Memory with A | EOR | 8Y | 2 | 2 | 88 | 2 | 4 | 83 | 3 | 2 | 82 | 1 4 | E8 | 3 2 | 2 | 8 | 3 | 9 |
| Arithmetic Compare A with Memory | CMP | A1 | 2 | 2 | B1 | 2 | 4 | ت ت | 3 | 5 | F1 | 1 4 | <u> </u> | 1 2 | 2 | D1 | 3 | 9 |
| Arithmetic Compare X | | | | | | | | | | | | | | | | | | |
| with Memory | CPX | . A3 | 2 | 2 | 83 | 2 | 4 | ខ | 3 | 2 | F3 | 1 4 | E3 | 3 | 2 | 23 | 3 | 9 |
| Bit Test Memory with A | ì | 3,4 | , | , | į | , | • | ŗ | | ı | | | | | | i d | | |
| (Logical Compare) | 118 | Ab | 7 | 7 | 8 | 7 | 4 | 3 | 7 | ۵ | 2 | - | <u>ا</u> | 7 | 1 | <u></u> | <u>س</u> | ٥ |
| Jump Unconditional | JMP | 1 | ı | 1 | BC | 2 | 3 | ပ္ပ | 3 | 4 | FC | 1 | EC | 2 | 4 | 2 | က | 2 |
| Jump to Subroutine | JSR | 1 | ı | 1 | BD | 2 | 7 | 8 | 3 | <u></u> | 9 | 1 7 | ED | 2 | <u>~</u> | OO | 3 | 6 |

Table 10-2. Read-Modify-Write Instructions

| Т | | _ | S | | _ | | | _ | | | | | _ | _ |
|---------|----------------|----|--|-----------|-----------|-------|------------|-------------------------|------------------------|-------------------------|--------------------|---------------------|------------------------|---------------------------|
| - | set) | # | Cycle | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 | 7 |
| Indexed | (8-Bit Offset) | # | Bytes | 2 | 7 | 2 | 7 | 7 | 2 | 7 | 2 | 2 | 7 | 2 |
| | <u>&</u> | o | Code | 29 | 94 | 49 | 63 | 09 | 69 | 99 | 89 | 64 | <i>L</i> 9 | G9 |
| _ | , 2 | # | Cycles | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 |
| hayabal | (No Offset) | # | Bytes | 1 | 1 | 1 | 1 | l | 1 | 1 | 1 | 1 | ı | 1 |
| | . S | dO | Code | 7C | ٧٧ | 7,5 | 73 | 0/ | 6/ | 76 | 78 | 74 | 77 | 70 |
| | | # | Cycles | 9. | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 | 9 |
| 0 | Direct | # | Bytes | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 | 2 |
| | | dO | Code | 3C | 3A | 3F | 33 | 30 | 36 | 36 | 38 | 34 | 37 | 30 |
| | Inherent (X) | # | Cycles | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 |
| | | # | Bytes | 1 | 1 | - | 1 | 1 | 1 | 1 | 1 | 1 | - | - |
| | Ξ | dO | Code | 2C | 2A | 5F | 53 | 20 | 29 | 26 | 28 | 54 | 22 | 2D |
| | 8 | # | Cycles | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 | 4 |
| | Inherent (A) | # | Bytes | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | 1 | - |
| | Ξ | dO | Code | 4C | 4A | 4F | 43 | 40 | 49 | 46 | 48 | 44 | 47 | 4D |
| | | | Mnemonic Code Bytes Cycles Code Bytes Cycles Code Bytes Cycles Code Bytes Cycles Code Bytes Cycles | INC | OEC | CLR | COM | NEG | ROL | ROR | ารา | LSR | ASR | TST |
| | | | Function | Increment | Decrement | Clear | Complement | Negate (2's Complement) | Rotate Left Thru Carry | Rotate Right Thru Carry | Logical Shift Left | Logical Shift Right | Arithmetic Shift Right | Test for Negative or Zero |

Table 10-3. Branch Instructions

| | | Relative | Addressin | g Mode |
|---|----------|------------|------------|-------------|
| Function | Mnemonic | Op Code | # Bytes | # Cycles |
| Branch Always | BRA | 20 | 2 | 4 |
| Branch Never | BRN | 21 | 2 . | 4 |
| Branch IFF Higher | BHI | 22 | 2 | 4 |
| Branch IFF Lower or Same | BLS | 23 | 2 | 4 |
| Branch IFF Carry Clear | BCC | 24 | 2 | 4 |
| (Branch IFF Higher or Same) | (BHS) | 24 | 2 | 4 |
| Branch IFF Carry Set | BCS | 25 | 2 | 4 |
| (Branch IFF Lower) | (BLO) | 25 | 2 | 4 |
| Branch IFF Not Equal | BNE | 26 | 2 | 4 |
| Branch IFF Equal | BEQ | 27 | 2 | 4 |
| Branch IFF Half Carry Clear | внсс | 28 | 2 | 4 |
| Branch IFF Half Carry Set | BHCS | 29 | 2 | 4 |
| Branch IFF Plus | BPL | 2A | 2 | 4 |
| Branch IFF Minus | ВМІ | 2B | 2 | 4 |
| Branch IFF Interrupt Mask Bit is Clear | вмс | 2C | 2 | 4 |
| Branch IFF Interrupt Mask Bit is Set | BMS | 2D | 2 | . 4 |
| Branch IFF Interrupt Line is Low | BIL | 2E | 2 | 4 |
| Branch IFF Interrupt Line is High | він | 2F | 2 | 4 |
| Branch to Subroutine | BSR | AD | 2 | 8 |

Table 10-4. Bit Manipulation Instructions

| | | | | Addressi | ng Modes | | |
|---------------------------|---------------|------------|------------|-------------|------------|------------|-------------|
| | | В | it Set/Cle | ar | Bit T | est and B | ranch |
| Function | Mnemonic | Op Code | # Bytes | # Cycles | Op Code | # Bytes | # Cycles |
| Branch IFF Bit n is Set | BRSET n(n=07) | _ | - | _ | 2•n | 3 | 10 |
| Branch IFF Bit n is Clear | BRCLR n(n=07) | _ | _ | _ | 01 + 2•n | 3 | 10 |
| Set Bit n | BSET n(n=07) | 10+2•n | 2 | 7 | - | _ | _ |
| Clear Bit n | BCLR n(n=07) | 11 + 2•n | 2 | 7 | - | - | _ |

Table 10-5. Control Instructions

| | | | Inherent | |
|--------------------------|----------|------------|------------|-------------|
| Function | Mnemonic | Op Code | # Bytes | # Cycles |
| Transfer A to X | TAX | 97 | 1 | 2 |
| Transfer X to A | TXA | 9F | 1 | 2 |
| Set Carry Bit | SEC | 99 | 1 | 2 |
| Clear Carry Bit | CLC | 98 | 1 | 2 |
| Set Interrupt Mask Bit | SEI | 9B | 1 | 2 |
| Clear Interrupt Mask Bit | CLI | 9A | 1 | 2 |
| Software Interrupt | SWI | 83 | 1 | 11 |
| Return from Subroutine | RTS | 81 | 1 | 6 |
| Return from Interrupt | RTI | 80 | 1 | 9 |
| Reset Stack Pointer | RSP | 9C | 1 | 2 |
| No-Operation | NOP | 9D | 1 | 2 |

Table 10-6. Instruction Set (Sheet 1 of 2)

| | | | | | | | | | | | | | | n C | ode |
|------|----------|-----------|--------|----------|----------|------------------------|---|----------------------|---|-------------------------|---|---|---|-----|-----|
| Mnem | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | | Indexed (16 Bits) | | Bit Test & Branch | н | ı | N | z | С |
| ADC | | X | Х | Х | | × | Х | Х | | | ٨ | • | ٨ | ٨ | ^ |
| ADD | | Х | X | X | | × | X | Х | | | ٨ | • | ٨ | ^ | ^ |
| AND | | Х | X | Х | | × | Х | Х | | | • | • | ٨ | ^ | • |
| ASL | Х | | X | | | × | X | | | | • | • | ^ | ٨ | |
| ASR | Х | | X | | | ·X | X | | | | • | • | ٨ | Λ | ^ |
| всс | | | | | X | | | | | | • | • | • | • | • |
| BCLR | | | | | | | | | Х | | • | • | • | • | • |
| BCS | | | | | X | | | | | | • | • | • | • | • |
| BEQ | | | | | Х | | | | | | • | • | • | • | • |
| внсс | | | | | X | | | | | | • | • | • | • | • |
| BHCS | | | | | X | | | | | | • | • | • | • | • |
| вні | | | | | Х | | | | | | • | • | • | • | • |
| BHS | | | | | X | | | | | 1 | • | • | • | • | • |
| він | | | | | X | | | | | | • | • | • | • | • |
| BIL | | | | | X | | | | | | • | • | • | • | • |
| BIT | | Х | X | X | | × | X | X | | | • | • | ٨ | ^ | • |
| BLO | | | | | X | | | | | | • | • | • | • | • |
| BLS | | | | | X | | | | | | • | • | • | • | • |
| вмс | | | | | X | | | | | | • | • | • | • | • |
| вмі | | | | | X | | | | | | • | • | • | • | • |
| BMS | | | | | X | | | | | | • | • | • | • | • |
| BNE | | | | | X | | | | | | • | • | • | • | • |
| BPL | | | | | X | | | | | | • | • | • | • | • |
| BRA | | | | | X | | | | | | • | • | • | • | • |

Condition Code Symbols:

- H Half Carry (From Bit 3)
- I Interrupt Mask
- C Carry/Borrow
- ↑ Test and Set if True, Cleared Otherwise
- N Negative (Sign Bit)
- Z Zero

Table 10-6. Instruction Set (Sheet 2 of 2)

| | | | | | | | | | | | | | tior | Condition Cod | | | | | |
|-------|----------|-----------|--------|----------|----------|------------------------|---|----------------------|---|-------------------------|---|---|----------|---------------|---|--|--|--|--|
| Mnem | Inherent | Immediate | Direct | Extended | Relative | Indexed (No Offset) | | Indexed (16 Bits) | 1 | Bit Test & Branch | н | | 2 | z | С | | | | |
| BRN | | | | | X | | | | | | • | • | • | • | • | | | | |
| BRCLR | | | | | | | | | | X | • | • | • | • | ^ | | | | |
| BRSET | | | | | | | | | | X | • | • | • | • | ٨ | | | | |
| BSET | | | | | | | | | X | | • | • | • | • | • | | | | |
| BSR | | | | | Х | | | | | | • | • | • | • | • | | | | |
| CLL | Х | | | | | | | | | | • | • | • | • | 0 | | | | |
| CLI | Х | | | | | | | | | | • | 0 | • | • | • | | | | |
| CLR | Х | | X | | | × | X | | | | • | • | 0 | 1 | • | | | | |
| CMP | | Х | X | X | | X | Х | X | | | • | • | ^ | ^ | ^ | | | | |
| сом | Х | | × | | | × | X | | | | • | • | ٨ | ٨ | 1 | | | | |
| CPX | | Х | × | Х | | X | Х | Х | | | • | • | ٨ | ٨ | ٨ | | | | |
| DEC | X | | X | | | X | Х | | | | • | • | ^ | ٨ | • | | | | |
| EOR | | X | X | Х | | × | Х | Х | | | • | • | ٨ | ٨ | • | | | | |
| INC | Х | | X | | | × | Х | | | | • | • | ^ | ^ | • | | | | |
| JMP | | | X | Х | | × | Х | X | | | • | • | • | • | • | | | | |
| JSR | | | X | Х | | Х | X | Х | | | • | • | • | • | • | | | | |
| LDA | | Х | Х | Х | | X | X | Х | | | • | • | Λ | ٨ | • | | | | |
| LDX | | Х | X | Х | | X | X | X | | | • | • | ^ | ^ | • | | | | |
| LSL | Х | | × | | | X | X | | | | • | • | ^ | ٨ | ٨ | | | | |
| LSR | Х | | Х | | | Х | Х | | | | • | • | 0 | ٨ | ٨ | | | | |
| NEQ | | | X | | | × | X | | | | • | • | <u> </u> | ^ | ^ | | | | |
| NOP | X | | | | | | | | | | • | • | • | • | • | | | | |
| ORA | Х | Х | × | Х | | × | X | × | | | • | • | ^ | ^ | • | | | | |
| ROL | Х | | X | | | X | Х | | | | • | • | ^ | Λ | ٨ | | | | |
| RSP | Х | | | | | | | | | | • | • | • | • | • | | | | |
| RTI | Х | | | | | | | | | | ? | ? | ? | ? | ? | | | | |
| RTS | Х | | | | | | | | | | • | • | • | • | • | | | | |
| SBC | | X | X | Х | | X | X | X | | | • | • | ^ | ^ | ٨ | | | | |
| SEC | Х | | | | | | | | | | • | • | • | • | 1 | | | | |
| SEI | X | | | | | | | | | | • | 1 | • | • | • | | | | |
| STA | | | × | Х | | Х | X | X | | | • | • | ^ | ^ | • | | | | |
| STX | | | X | Х | | Х | Х | Х | | | • | • | \land | | • | | | | |
| SUB | | X | Х | Х | | Х | X | X | | | • | • | ^ | ٨ | ٨ | | | | |
| SWI | X | | | | | | | | | | • | 1 | • | • | • | | | | |
| TAX | × | | | | | | | | | | • | • | • | • | • | | | | |
| TST | X | | X | | | Х | X | | | | • | • | ^ | ^ | • | | | | |
| TXA | × | | | | | | | | | | • | • | • | • | • | | | | |

Condition Code Symbols:

- H Half Carry (From Bit 3)
- I Interrupt Mask
- N Negative (Sign Bit)
 Z Zero

- C Carry/Borrow

 ↑ Test and Set if True, Cleared Otherwise
- Not Affected
 Load CC Register From Stack

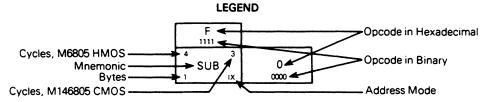
Table 10-7. M6805 HMOS Family Instruction Set Opcode Map

| | Bit Man | ipul a tion | Branch | | | | | |
|-----------|-----------------|--------------------|---------|-------------|--|--|------------------|--------------|
| | BTB | BSC | REL | DIR | Α | X | IX1 | IX |
| Hi | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 |
| Low | 0000 | 0001 | 0010 | 0011 | 0100 | 0101 | 0110 | 0111 |
| 0 | BRSETO 5 | BSET0 5 | 4 BRA | 6 NEG | 4 NEG | 4 NEG 3 | 7 NEG 6 | 6 NEG 5 |
| 0000 | 3 878 | 2 BSC | 2 REL | 2 DIR | 1 A | 1 X | 2 IX1 | 1 IX |
| 1 | BRCLR0 | BCLR0 | BRN | | | | | |
| 0001 | з втв | 2 BSC | | | | | ļ <u> </u> | |
| 2 | BRSET1 | BSET1 | BHI | | | | | |
| wi0 | 10 5 | | | | ļ | | 1 | |
| 3 | BRCLR1 | BCLR1 | BLS | СОМ | СОМ | СОМ | 7 COM 6 2 IX1 | COM 1 |
| - w.i | 10 5 | | | | | | | 6 5 |
| 4 0100 | BRSET2 | BSET2 | BCC | LSR | LSR | LSR | LSR | LSR |
| 0.00 | 10 5 | | | 2 DIN | | | 12 121 | · |
| 5 0101 | BRCLR2 3 BTB | BCLR2 | BCS | | | | | |
| 6 | BRSET3 | BSET3 | BNE | ROR | ROR | ROR | ROR | 6 ROR |
| 0110 | 3 BTB | | | | | 1 x | 2 IX1 | 1 IX |
| 7 | BRCLR3 | BCLR3 | BEQ | ASR | ASR | ASR | ASR | 6 ASR 5 |
| 0111 | з втв | | | | <u> </u> | | 2 IX1 | |
| 8 | BRSET4 | BSET4 2 BSC | внсс | LSL | LSL | LSL | LSL | 6 LSL |
| 1000 | | | | | | | | |
| 9 | BRCLR4 | BCLR4 BSC | BHCS | ROL | ROL | ROL | 7 ROL 2 IX1 | ROL |
| 100. | 10 5 | | | | | | | 6 5 |
| A 1010 | BRSET5 | BSET5 | BPL | DEC | DEC | DEC | DEC IX1 | DEC |
| В | 10 5 BRCLR5 | | | | | | | |
| 1011 | з втв | 1 | 2 REL | ì | İ | i | 1 | 1 |
| С | 10 5 BRSET6 | | | 6 5 | 4 INC | 4 INC | 7 6 | 6 INC |
| 1100 | 3 818 | 1 | 2 REL | 2 DIR | 1 A | 1 x | 2 IX1 | 1 IX |
| D | 10 5 BRCLR6 | BCLR6 | 4 BMS 3 | 6 TST | 4 TST | 4 TST | 7 TST | 6 TST |
| 1101 | 3 878 | 2 BSC | 2 REL | 2 DIR | 1 A | 1 x | 2 IX1 | 1 IX |
| E | BRSET7 | BSET7 | BIL | | | | | |
| 1110 | з втв | | | | ļ | | ļ | ļ |
| F | BRCLR7 | BCLR7 | BIH | CLR | CLR | CLR | CLR | 6 CLR 5 |
| 1111 | 3 818 | | 2 REL | 2 DIR | | 1 x | 2 IX1 | 1 IX |

Abbreviations for Address Modes

| INH | Inherent | EXT | Extended | IX | Indexed (No Offset) |
|-----|----------------|-----|---------------------|-----|---------------------------------|
| Α | Accumulator | REL | Relative | IX1 | Indexed, 1 Byte (8-Bit) Offset |
| X | Index Register | BSC | Bit Set/Clear | IX2 | Indexed, 2 Byte (16-Bit) Offset |
| IMM | Immediate | BTB | Bit Test and Branch | * | M146805 CMOS Family Only |
| DIR | Direct | | | | |

| Con | ntroi | Т | | | | _ | Register | /N | lemory | | | | | |
|--------------|------------------|---------|-----------|---|-----------|----|------------|----|------------|----|-----------|---|-----------|--|
| INH | INH | \top | IMM | | DIR | _ | EXT | Ť | IX2 | | IX1 | Γ | IX | |
| 8 | 9 | 1 | A 1010 | | B 1011 | | C 1100 | | D 1101 | | E 1110 | | F 1111 | Hi Low |
| 9 9 RTI | | 2 | SUB | 4 | SUB | 5 | SUB | | SUB | 5 | SUB | 4 | SUB | 0 |
| 1 INH | | 2 | IMM | _ | DIR | _ | EXT | _ | | _ | | _ | | 0000 |
| RTS | | 2 | CMP IMM | 4 | CMP DIR | | CMP EXT | | CMP IX2 | ļ | CMP IX1 | | CMP | 1 0001 |
| 1417 | | _ | | 4 | | | | | 5 | | | _ | | |
| | | 2 | SBC | | SBC | | SBC | | SBC | | SBC | ľ | SBC | 2 0010 |
| 11 10 SWI | | 2 | CPX 2 | 4 | CPX 3 | 5 | | | CPX 5 | | | 4 | CPX 3 | 3 |
| 1 INH | | _ | IMM | - | | 1 | | L | | _ | | | | 0011 |
| | | 2 | AND | 4 | AND | | AND | | AND 5 | | AND | | AND | 4 |
| | | 2 | | 4 | 3 | - | | _ | | _ | | 4 | | 0100 |
| | | 2 | BIT | | BIT | | BIT | | BIT ix2 | | BIT | | BIT | 5 0101 |
| | | 2 | | | LDA 3 | | | | LDA 5 | _ | | 4 | LDA 3 | 6 |
| | | 2 | IMM: | 2 | Dir | | | | IX2 | | | | | 0110 |
| | TAX | 2 | | | STA 4 | 1 | STA | | STA 6 | | STA | | STA | 7 |
| | 1 INI | 2 2 | | _ | | _ | | _ | 1X2 5 | _ | | _ | | 0111 |
| | CLC | 1 2 | EOR | ĺ | EOR | | EOR | | EOR IX2 | ı | EOR | | EOR | 8 |
| | SEC | 2 2 | ADC 2 | 4 | ADC 3 | 5 | ADC 4 | 6 | ADC 5 | 5 | ADC 4 | 4 | ADC 3 | 9 |
| | 1 INI | 1 2 2 2 | | | | _ | | _ | | _ | | - | IX | 1001 |
| | CLI | | ORA IMM | | ORA | 1 | ORA | ı | ORA | | ORA | | ORA | A 1010 |
| | ² SEI | 2 2 | ADD 2 | 4 | ADD 3 | 5 | ADD 4 | 6 | ADD 5 | 5. | | - | | В |
| | 1 IN | - | IMM | - | DIR | - | | | IX2 | | IX1 | | IX | 1011 |
| | RSP | Ì | | 2 | JMP DIR | ١ | JMP EXT | ١ | JMP | 1 | JMP | İ | JMP | C |
| | 1 INI 2 | | 6 | | | | | | | | 1X1 6 | 7 | 1X 5 | 1100 |
| | NOP INI | 1 | BSR | | JSR | | JSR EXT | 3 | JSR IX2 | 2 | JSR IX1 | | JSR | D 1101 |
| *STOP 2 | | 2 | LDX 2 | 4 | LDX 3 | 5 | LDX 4 | 6 | LDX 5 | 5 | LDX 4 | 4 | LDX 3 | E |
| 1 INH | | 2 | IMM | | DIR | | EXT | | | 2 | IX1 | 1 | IX | 1110 |
| WAIT | TXA | | | 5 | STX DIR | | STX | | STX 6 | | STX 5 | | STX | F |
| L | <u>ı· ""</u> | ·′′_ | | Ľ | אוט | ۲, | EVI | டி | 1/2 | Ľ | 101 | Ľ | 1.4 | 1 '''' |



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SECTION 11 ELECTRICAL CHARACTERISTICS

11.1 MAXIMUM RATINGS

| Rating | Symbol | Value | Unit |
|--|------------------------------------|--|-------------|
| Supply Voltage | Vcc | -0.3 to $+7.0$ | ٧ |
| Input Voltage MC6805R2, MC6805R3, MC6805U2, and MC6805U3 (Except TIMER in Self-Check Mode and Open-Drain Inputs) Self-Check Mode (TIMER Pin Only) | V _{in} V _{in} | -0.3 to +7.0 -0.3 to +15.0 | V V |
| MC68705R3/MC68705U3 EPROM Programming Voltage (Vpp Pin) TIMER Pin — Normal Mode TIMER Pin — Bootstrap Programming Mode All Others | Vpp V _{in} | -0.3 to +22.0 -0.3 to +7.0 -0.3 to +15.0 -0.3 to +7.0 | > > > |
| Operating Temperature Range MC6805R2, MC6805U2, MC6805R3, MC6805U3, MC68705R3, MC68705U3, MC68705R5, MC68705U5 MC6805R2C, MC6805U2C, MC6805R3C, MC6805U3C, MC68705R3C, MC68705U3C, MC68705R5C, MC68705U3C, MC68705R5C, MC68705U5C MC6805R2V, MC6805U2V, MC6805R3V, MC6805U3V | V _{in} | T _L to T _H 0 to +70 -40 to 85 -40 to 105 | °C |
| Storage Temperature Range | T _{stg} | -55 to +150 | ပ္ |
| Junction Temperature Plastic Ceramic Cerdip | Ty | 150 175 175 | °C/W |

These devices contain circuitry to protect the inputs against damage due to high static voltages or electrical fields; however, it is advised that normal precautions be taken to avoid application of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range $VSS \leq (V_{in} \text{ and } V_{out}) \leq VCC$. Reliability of operation is enhanced if unused inputs except EXTAL are tied to an appropriate logic voltage level (e.g., either VSS or VCC).

11.2 THERMAL CHARACTERISTICS

| Characteristic | Symbol | Value | Unit |
|--|-----------------|-------|------|
| Thermal Resistance Plastic (P Suffix) — MC6805R2, MC6805U2, MC6805R3, MC6805U3 | | 60 | |
| Ceramic — MC6805R2, MC6805U2, MC6805R3, MC6805U3, MC68705R3, MC68705U3, MC68705R5, MC68705U5 | θ _{JA} | 50 | °C/W |
| Cerdip — MC6805R2, MC6805U2, MC6805R3 MC6805U3, MC68705R5, MC68705U5 | | 60 | |

11.3 POWER CONSIDERATIONS

The average chip-junction temperature, TJ, in °C can be obtained from:

$$TJ = TA + (PD \bullet \theta JA)$$

Where:

TA = Ambient Temperature, °C

 θ JA = Package Thermal Resistance, Junction-to-Ambient, °C/W

PD≡PINT+PPORT

PINT≡ICC×VCC, Watts - Chip Internal Power

PPORT≡Port Power Dissipation, Watts - User Determined

For most applications PPORT

PINT and can be neglected. PPORT may become significant if the device is configured to drive Darlington bases or sink LED loads.

An appropriate relationship between PD and TJ (if PPORT is neglected) is:

$$P_D = K \div (T_J + 273^\circ) \tag{2}$$

Solving equations 1 and 2 for K gives:

$$K = P_D \bullet (T_A + 273 \circ C) + \theta_{JA} \bullet P_D \stackrel{?}{2}$$
(3)

Where K is a constant pertaining to the particular part. K can be determined from equation 3 by measuring PD (at equilibrium) for a known TA. Using this value of K the values of PD and TJ can be obtained by solving equations (1) and (2) iteratively for any value of TA.

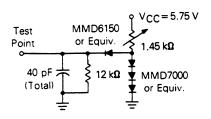


Figure 11-1. TTL Equivalent Test Load (Port B)

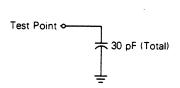


Figure 11-2. CMOS Equivalent Test Load (Port A)

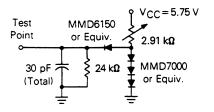


Figure 11-3. TTL Equivalent Test Load (Ports A and C)

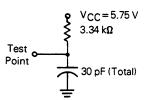


Figure 11-4. Open-Drain Equivalent Test Load (Port C)

11.4 MC6805R2 AND MC6805R3

11.4.1 Electrical Characteristics (V_{CC} = +5.25 Vdc ±0.5 Vdc, V_{SS} =0 Vdc, T_A = T_L to T_H unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit [.] |
|---|------------------|---|----------------|----------------------------------|---------------------|
| Input High Voltage RESET (4.75≤V _{CC} ≤5.75) (V _{CC} <4.75) INT (4.75≤V _{CC} ≤5.75) (V _{CC} <4.75) All Other | Vін | 4.0 V _{CC} -0.5 4.0 V _{CC} -0.5 2.0 | - * * | 00 00 00 00 00 00 | ٧ |
| Input High Voltage Timer Timer Mode Self-Check Mode | ViH . | 2.0 9.0 | - 10.0 | V _{CC} + 1.0 | ٧ |
| Input Low Voltage RESET INT All Other (Except A/D Inputs) | VIL | Vss Vss Vss | - * - | 0.8 1.5 0.8 | ٧ |
| RESET Hysteresis Voltages (See Figures 7-1, 7-2, and 7-3) "Out of Reset" "Into Reset" | VIRES+ VIRES- | 2.1 0.8 | - - | 4.0 2.0 | ٧ |
| INT Zero Crossing Input Voltage, Through a Capacitor | VINT | 2 | _ | 4 | V _{ac p-p} |
| Power Dissipation — (No Port Loading, V_{CC} =5.75 V T_A =0°C for Steady-State Operation) T_A = -40°C | PD | - | 520 580 | 740 800 | mW |
| Input Capacitance XTAL All Other Except Analog Inputs (See Note) | C _{in} | <u>-</u> - | 25 10 | - | pF |
| Low Voltage Recover | V _{LVR} | _ | - | 4.75 | V |
| Low Voltage Inhibit | V _{LVI} | 2.75 | 3.75 | 4.70 | V |
| Input Current $ \begin{array}{l} \text{TIMER (V_{in}=0.4)} \\ \text{INT (V_{in}=2.4 V to V_{CC})} \\ \text{EXTAL (V_{in}=2.4 V to V_{CC} Crystal Option)} \\ \text{(V_{in}=0.4 V Crystal Option)} \\ \hline \text{RESET (V_{in}=0.8 V)} \\ \text{(External Capacitor Charging Current)} \end{array} $ | l _{in} | - - - -4.0 | 20 | 20 50 10 – 1600 – 40 | μΑ |

NOTE: Port D Analog Inputs, when selected, C_{in} = 25 pF for the first 5 out of 30 cycles. *Due to internal biasing this input (when unused) floats to approximately 2.0 V.

MC6805R2 AND MC6805R3

11.4.2 Switching Characteristics (VCC= \pm 5.25 Vdc \pm 0.5 Vdc, VSS=0 Vdc, TA=TL to TH

| Characteristic | .Symbol | Min | Тур | Max | Unit |
|---|----------|------------------------|-----|-----|------|
| Oscillator Frequency | fosc | 0.4 | _ | 4.2 | MHz |
| Cycle Time (4/f _{osc}) | tcyc | 0.95 | - | 10 | μS |
| INT, INT2, and TIMER Pulse Width | tWL, tWH | t _{cyc} + 250 | _ | - | ns |
| RESET Pulse Width | tRWL | t _{CyC} + 250 | _ | _ | ns |
| INT Zero-Crossing Detection Input Frequency | fINT | 0.03 | - | 1 | kHz |
| External Clock Input Duty Cycle (EXTAL) | _ | 40 | 50 | 60 | % |
| Crystal Oscillator Start-Up Time* | - | _ | _ | 100 | ms |

^{*} See Figure 7-5 for typical crystal parameters.

11.4.3 A/D Converter Characteristics (V_{CC} = +5.25 Vdc ±0.5 Vdc, V_{SS} = 0 Vdc, T_A = T_L to T_H unless otherwise noted)

| | Min | Тур | Max | Unit | Comments |
|--------------------------------|-----------------|-----------|--------------|------------------|--|
| Resolution | 8 | 8 | 8 | Bits | |
| Non-Linearity | - | - | ± 1/2 | LSB | For $V_{RH} = 4.0$ to 5.0 V and $V_{RL} = 0$ V |
| Quantizing Error | - | - | ± 1/2 | LSB | |
| Conversion Range | VRL | - | VRH | V , | |
| `V _{RH} | _ | _ | Vcc | ٧ | A/D accuracy may decrease proportionately as |
| V _{RL} | ٧ss | - | 0.2 | V | V_{RH} is reduced below 4.0 V. The sum of V_{RH} and |
| | | | | | V _{RL} must not exceed V _{CC} . |
| Conversion Time | 30 | 30 | 30 | t _{cyc} | Includes sampling time |
| Monotonicity | Int | erent (wi | thin total e | error) | |
| Zero Input Reading | 00 | 00 | 01 | hexadecimal | V _{in} = 0 |
| Ratiometric Reading | FE | FF | FF | hexadecimal | V _{in} = V _{RH} |
| Sample Time | 5 | 5 | 5 | tcyc | |
| Sample/Hold Capacitance, Input | - | _ | 25 | pF | |
| Analog Input Voltage | V _{RL} | - | VRH | ٧ | Negative transients on any analog lines (Pins 19-24) are not allowed at any time during conversion |

MC6805R2 AND MC6805R3

11.4.4 Port Electrical Characteristics (V_{CC} = +5.25 Vdc ±0.5 Vdc, V_{SS} =0 Vdc, T_A = T_L to T_H unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|---------------------|--------------------|-----|-------------|-------------|
| | | Т Т | | | |
| Output Low Voltage I _{Load} = 1.6 mA | VOL | | | 0.4 | V |
| Output High Voltage $I_{Load} = -100 \mu$ A | Voн | 2.4 | | <u> </u> | V |
| Output High Voltage I _{Load} = -10 μA | Voн | V _{CC} -1 | | - | V |
| Input High Voltage I _{Load} = -300 μA (max) | ViH | 2.0 | _ | VCC | V |
| Input Low Voltage I _{Load} = -500 µA (max) | VIL | Vss | _ | 0.8 | V |
| Hi-Z State Input Current (Vin=2.0 V to VCC) | ЧН | _ | _ | - 300 | μΑ |
| Hi-Z State Input Current (Vin=0.4 V) | ١ _١ ٢ | _ | _ | - 500 | μΑ |
| | Port B | | | | |
| Output Low Voltage I _{Load} =3.2 mA | VOL | - | _ | 0.4 | ٧ |
| Output Low Voltage I _{Load} = 10 mA (sink) | VOL | _ | _ | 1.0 | V |
| Output High Voltage I _{Load} = -200 μA | Voн | 2.4 | _ | - | V |
| Darlington Current Drive (Source) V _O = 1.5 V | ЮН | - 1.0 | - | - 10 | mA |
| Input High Voltage | VIH | 2.0 | | Vcc | V |
| Input Low Voltage | ۷٫۱ | VSS | _ | 0.8 | ٧ |
| Hi-Z State Input Current | ITSI | _ | <2 | 10 | μА |
| Port C and Port A | with CMOS Devi | ce Disabled | | | |
| Ouput Low Voltage I _{Load} = 1.6 mA | VOL | _ | - | 0.4 | V. |
| Output High Voltage I _{Load} = -100 μA | Voн | 2.4 | _ | T = | ٧ |
| Input High Voltage | VIH | 2.0 | _ | Vcc | ٧ |
| Input Low Voltage | V _{IL} | VSS | _ | 0.8 | ٧ |
| Hi-Z State Input Current | ^I TSI | | <2 | 10 | μΑ |
| Port C (C | Open-Drain Option | 1) | | | |
| Input High Voltage | ViH | 2.0 | _ | 13.0 | V |
| Input Low Voltage | VIL | VSS | _ | 0.8 | V |
| Input Leakage Current (Vin=13.0 V) | ILOD | _ | <3 | 15 | μΑ |
| Output Low Voltage I _{Load} = 1.6 mA | VOL | - | _ | 0.4 | V. |
| Port D (C | Digital Inputs Only |) | | | |
| Input High Voltage | VIH | 2.0 | _ | Vcc | V |
| Input Low Voltage | ۷۱۲ | VSS | | 0.8 | V |
| Input Current * | lin | - | <1 | 5 | μА |

^{*}PD4/V_{RL}-PD5/V_{RH}: The A/D conversion resistor (15 kΩ typical) is connected internally between these two lines, impacting their use as digital inputs in some applications.

11.5 MC6805U2 AND MC6805U3

11.5.1 Electrical Characteristics (V_{CC} = +5.25 Vdc ±0.5 Vdc, V_{SS} =0 Vdc, T_A = T_L to T_H unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | ·Unit |
|--|------------------|---|------------------|----------------------------------|---------------------|
| Input High Voltage RESET (4.75≤V _{CC} ≤5.75) (V _{CC} <4.75) INT (4.75≤V _{CC} ≤5.75) (V _{CC} <4.75) All Other (Except Timer) | VIH | 4.0 V _{CC} -0.5 4.0 V _{CC} -0.5 2.0 | - - * * | Vcc Vcc Vcc Vcc | ٧ |
| Input High Voltage Timer Timer Mode Self-Check Mode | VIH | 2.0 9.0 | _ 10.0 | V _{CC} +1.0 | V |
| Input Low Voltage RESET INT All Other | VIL | Vss Vss Vss | * | 0.8 1.5 0.8 | ٧ |
| RESET Hysteresis Voltages (See Figures 7-1, 7-2, and 7-3) "Out of Reset" "Into Reset" | VIRES+ VIRES- | 2.1 0.8 | <u>-</u> | 4.0 2.0 | ٧ |
| INT Zero Crossing Voltage, Through a Capacitor | VINT | 2 | _ | 4 | V _{ac p-p} |
| Internal Power Dissipation (No Port Loading, V_{CC} =5.75 V T_A =0°C for Steady-State Operation) T_A = -40°C | PINT | | 520 580 | 740 800 | mW |
| Input Capacitance XTAL All Other | C _{in} | | 25 10 | - | pF |
| Low Voltage Recover | VLVR | _ | _ | 4.75 | V |
| Low Voltage Inhibit | VLVI | 2.75 | 3.75 | 4.70 | V |
| Input Current | lin IRES | - - - - -4.0 | 20 | 20 50 10 - 1600 - 40 | μΑ |

11.5.2 Switching Characteristics (V_{CC} = +5.25 Vdc ±0.5 Vdc, V_{SS} = 0 Vdc, T_A = T_L to T_H unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|------------------|------------------------|-----|-----|------|
| Oscillator Frequency | fosc | 0.4 | - | 4.2 | MHz |
| Cycle Time (4/f _{osc}) | t _{cyc} | 0.95 | _ | 10 | μS |
| INT, INT2, and TIMER Pulse Width | tWL, tWH | t _{cyc} + 250 | _ | - | ns |
| RESET Pulse Width | ^t RWL | t _{cyc} + 250 | _ | - | ns |
| RESET Delay Time (External Cap = 1 μF) | ^t RHL | - | 100 | - | ms |
| INT Zero Crossing Detection Input Frequency | fINT | 0.03 | - | 1.0 | kHz |
| External Clock Input Duty Cycle (EXTAL) | _ | 40 | 50 | 60 | % |
| Crystal Oscillator Start-Up Time * | | - | _ | 100 | ms |

^{*}See Figure 7-5 for typical crystal parameters.

MC6805U2 AND MC6805U3

11.5.3 Port Electrical Characteristics (V_{CC} = +5.25 Vdc ±0.5 Vdc, V_{SS} =0 Vdc, T_A = T_L to T_H unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|-----------------------|----------------------|-----|------|------|
| Port A with CM | OS drive enabled | | | | |
| Output Low Voltage I _{Load} = 1.6 mA | VOL | - | _ | 0.4 | V |
| Output High Voltage I _{Load} = -100 μA | Voн | 2.4 | _ | _ | V |
| Output High Voltage I _{Load} = -10 μA | Voн | V _{CC} -1.0 | | | ٧ |
| Input High Voltage I _{Load} = -300 µA (max) | VIH | 2.0 | _ | Vcc | V |
| Input Low Voltage I _{Load} = -500 μA (max) | V _I L | VSS | - | 0.8 | V |
| Hi-Z State Input Current (V _{in} = 2.0 V to V _{CC}) | liн | - | - | -300 | μΑ |
| Hi-Z State Input Current (V _{in} = 0.4 V) | IIL | _ | | -500 | μΑ |
| Po | ort B | | | | |
| Output Low Voltage I _{Load} =3.2 mA | VOL | - | - | 0.4 | ٧ |
| Output Low Voltage I _{Load} = 10 mA (sink) | VOL | - | _ | 1.0 | ٧ |
| Output High Voltage I _{Load} = -200 μA | Voн | 2.4 | _ | | ٧ |
| Darlington Current Drive (Source) V _O = 1.5 V | loн | -1.0 | - | - 10 | mA |
| Input High Voltage | ViH | 2.0 | - | Vcc | ٧ |
| Input Low Voltage | VIL | VSS | _ | 0.8 | ٧ |
| Hi-Z State Input Current | ^I T\$I | _ | <2 | 10 | μΑ |
| | vith CMOS drive disab | led | | | |
| Output Low Voltage I _{Load} = 1.6 mA | VOL | _ | | 0.4 | V |
| Output High Voltage I _{Load} = -100 μA | Voн | 2.4 | - | | V |
| Input High Voltage | ViH | 2.0 | _ | Vcc | V |
| Input Low Voltage | V _{IL} | V _{SS} | | 0.8 | ٧ |
| Hi-Z State Input Current | İTSI | - | <2 | 10 | μΑ |
| Port C (Open-L | | | | | |
| Input High Voltage | VIH | 2.0 | - | 13.0 | ٧ |
| Input Low Voltage | VIL | VSS | _ | 0.8 | V |
| Input Leakage Current (V _{in} = 13.0 V) | ILOD | - | <3 | 15 | μΑ. |
| Output Low Voltage I _{Load} = 1.6 mA | V _{OL} | | | 0.4 | ٧ |
| Input High Voltage | ViH | 2.0 | | Vcc | V |
| Input Low Voltage | ۷۱۲ | VSS | _ | 0.8 | V |
| Input Current | lin | - | <1 | 5 | μΑ |

11.6 MC68705R3 AND MC68705R5

11.6.1 Programming Operation Electrical Characteristics ($V_{CC} = 5.25 \text{ Vdc } \pm 0.5, V_{SS} = 0, T_A = 20^{\circ}$ to 30°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|---------|------|--------|---------|------|
| Programming Voltage | Vpp | 20.0 | 21.0 | 22.0 | ٧ |
| Vpp Supply Current Vpp = 5.25 V Vpp = 21.0 V | IPP | _ | - - | 8 30 | mA |
| Oscillator Frequency | fosc(p) | 0.9 | 1.0 | 1.1 | MHz |
| Bootstrap Programming Mode Voltage (TIMER Pin) @ I _{IHTP} = 100 µA Max | VIHTP | 9.0 | 12.0 | 15.0 | ٧ |

11.6.2 Electrical Characteristics ($V_{CC} = +5.25 \text{ Vdc} \pm 0.5 \text{ Vdc}$, $V_{SS} = 0 \text{ Vdc}$, $T_A = 0^{\circ}$ to 70° C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|------------------|-----------------------------|------------------------|----------------------------------|---------------------|
| Input High Voltage RESET (4.75≤V _{CC} ≤5.75) (V _{CC} <4.75) | | 4.0 V _{CC} -0.5 | - | Vcc Vcc | ٧ |
| INT (4.75≤V _{CC} ≤5.75) (V _{CC} <4.75) | VIH | 4.0 V _{CC} -0.5 | ** | VCC VCC | ٧ |
| All Other | | 2.0 | - | vcc | V |
| Input High Voltage (TIMER Pin) Timer Mode Bootstrap Programming Mode | VIН | 2.0 9.0 | _ 12.0 | V _{CC} +1.0 | V V |
| Input Low Voltage RESET INT All Other | V _{IL} | VSS VSS VSS | ** | 0.8 1.5 0.8 | V V V |
| INT Zero-Crossing Input Voltage — Through a Capacitor | VINT | 2.0 | _ | 4.0 | V _{ac p-p} |
| Internal Power Dissipation (No Port Loading, $V_{CC} = 5.25 \text{ V}$ $T_A = 0^{\circ}\text{C}$ for Steady-State Operation) $T_A = -40^{\circ}\text{C}$ | PINT | - | 520 580 | 740 800 | mŴ |
| Input Capacitance EXTAL All Other (See Note) | C _{in} | | 25 10 | - - | pF pF |
| RESET Hysteresis Voltage (See Figure 7-1) Out of Reset Voltage Into Reset Voltage | VIRES+ VIRES- | 2.1 0.8 | <u>-</u> | 4.0 2.0 | V V |
| Programming Voltage (Vpp Pin) Programming EPROM Operating Mode | Vpp* | 20.0 4.75 | 21.0 VCC | 22.0 5.75 | V V |
| Input Current TIMER (V _{in} = 0.4 V) INT (V _{in} = 0.4 V) EXTAL (V _{in} = 2.4 V to V _{CC}) (V _{in} = 0.4 V) RESET (V _{in} = 0.8 V) (External Capacitor Changing Current) | I _{in} | - - - - -4.0 | - 20 - - - | 20 50 10 - 1600 - 40 | μΑ |

^{*}Vpp is pin 7 on the MC68705R3 and MC68705R5 and is connected to V_{CC} in the normal operating mode. In the MC6805R2, pin 7 is connected to V_{SS} in the normal operating mode. The user must allow for this difference when emulating the MC6805R2 ROM-based MCU.

NOTE: Port D analog inputs, when selected, C_{in} = 25 pF for the first 5 out of 30 cycles.

^{**}Due to internal biasing, this input (when not used) floats to approximately 2.0 V.

MC68705R3 AND MC68705R5

11.6.3 Switching Characteristics (V_{CC} = +5.25 Vdc ±0.5 Vdc, V_{SS} =0 Vdc, T_A =0° to 70°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|------------------------|----------|-----|------|
| Oscillator Frequency | | | <u> </u> | | |
| Normal | fosc | 0.4 | _ | 4.2 | MHz |
| Instruction Cycle Time (4/f _{osc}) | tcyc | 0.950 | _ | 10 | μS |
| INT, INT2, or Timer Pulse Width | tWL, tWH | t _{cyc} + 250 | - | _ | ns |
| RESET Pulse Width | tRWL | t _{cyc} ÷ 250 | - | - | ns |
| RESET Delay Time (External Cap = 1.0 μF) | ^t RHL | _ | 100 | _ | ms |
| INT Zero Crossing Detection Input Frequency | fINT | 0.03 | _ | 1.0 | kHz |
| External Clock Duty Cycle (EXTAL) | - | 40 | 50 | 60 | % |
| Crystal Oscillator Start-Up Time!* | _ | - | _ | 100 | ms |

^{*}See Figure 7-5 for typical crystal parameters.

11.6.4 A/D Converter Characteristics (V_{CC} = +5.25 V ±0.5 Vdc, V_{SS} =0 Vdc, T_A =0° to 70°C unless otherwise noted)

| Characteristic | Min | Тур | Max | Unit | Comments |
|--------------------------------|-----|-----|-------------|------------------|---|
| Resolution | 8 | 8 | 8 | Bits | |
| Non-Linearity | - | - | ±1/2 | LSB | For $V_{RH} = 4.0$ to 5.0 V and $V_{RL} = 0$ V. |
| Quantitizing Error | - | _ | ± 1/2 | LSB | |
| Conversion Range | VRL | _ | VRH | ٧ | |
| VRH | - | _ | Vcc | ٧ | A/D accuracy may decrease proportionately as |
| V _{RL} | Vss | - | 0.2 | V | V _{RH} is reduced below 4.0 V. The sum of V _{RH} and |
| | | | | | VRL must not exceed VCC. |
| Conversion Time | 30 | 30 | 30 | tcyc | Includes sampling time |
| Monotonicity | | inh | erent (with | nin total error) | |
| Zero Input Reading | 00 | 00 | 01 | hexadecimal | V _{in} =0 |
| Ratiometric Reading | FE | FF | FF | hexadecimal | $V_{in} = V_{RH}$ |
| Sample Time | 5 | 5 | 5 | t _{cyc} | |
| Sample/Hold Capacitance, Input | | - | 25 | pF | |
| Analog Input Voltage | VRL | | VRH | ٧ | Negative transients on any analog lines (pins 19-24) are not allowed at any time during conversion. |

MC68705R3 AND MC68705R5

11.6.5 Port Electrical Characteristics (V_{CC}= \pm 5.25 Vdc \pm 0.5 Vdc, V_{SS}=0 Vdc, T_A=0° to 70°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|---|-------------------|----------------------|-----|--------------|------|
| | Port A | | | | • |
| Output Low Voltage, I _{Load} = 1.6 mA | VOL | | _ | 0.4 | ٧ |
| Output High Voltage, I _{Load} = -100 μA | Voн | 2.4 | _ | - | ٧ |
| Output High Voltage, I _{Load} = -10 μA | Voн | V _{CC} -1.0 | _ | _ | V |
| Input High Voltage, $I_{Load} = -300 \mu\text{A}$ (Max) | VIH | 2.0 | _ | Vcc | ٧ |
| Input Low Voltage, I _{Load} = -500 µA (Max) | VIL | Vss | _ | 0.8 | V |
| Hi-Z State Input Current (Vin = 2.0 V to VCC) | IIH | T - 1 | - | -300 | μΑ |
| Hi-Z State Input Current (V _{in} = 0.4 V) | IIL | - 1 | _ | -500 | μΑ |
| | Port B | | | | |
| Output Low Voltage, I _{Load} =3.2 mA | VOL | _ | _ | 0.4 | ٧ |
| Output Low Voltage, ILoad = 10 mA (Sink) | VOL | 1 - 1 | - | 1.0 | ٧ |
| Output High Voltage, I _{Load} = -200 μA | V _{OH} . | 2.4 | _ | - | V |
| Darlington Current Drive (Source), V _O = 1.5 V | 10н | -1.0 | _ | -10 | mA |
| Input High Voltage | VIH | 2.0 | _ | Vcc | . V |
| Input Low Voltage | VIL | Vss | - | 0.8 | V |
| Hi-Z State Input Current | ^I TSI | _ | <2 | 10 | μА |
| P | ort C | | | | |
| Output Low Voltage, I _{Load} = 1.6 mA | VOL | _ | _ | 0.4 | V |
| Output High Voltage, I _{Load} = -100 μA | Voн | 2.4 | _ | _ | V |
| Input High Voltage | VIH | 2.0 | _ | Vcc | ·V |
| Input Low Voltage | V _{IL} | Vss | _ | 0.8 | ٧ |
| Hi-Z State Input Current | ^I TSI | - | <2 | 10 | μА |
| Port D | (Input Only) | | | | |
| Input High Voltage | ViH | 2.0 | - | Vcc | ٧ |
| Input Low Voltage | ViL | VSS | | 0.8 | ٧ |
| Input Current | lin | _ | <1 | 5 | μА |

11.7 MC68705U3 AND MC68705U5

11.7.1 Programming Operation Electrical Characteristics ($V_{CC} = 5.25 \text{ Vdc} \pm 0.5$, $V_{SS} = 0 \text{ Vdc}$, $T_A = 20^{\circ}$ to 30°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|--------|------|------|---------|------|
| Programming Voltage | Vpp | 20.0 | 21.0 | 22.0 | ٧ |
| Vpp Supply Current Vpp = 5.25 V Vpp = 21.0 V | Ірр | _ | | 8 30 | mA |
| Programming Oscillator Frequency | foscp | 0.9 | 1.0 | 1.1 | MHz |
| Bootstrap Programming Mode Voltage (TIMER Pin)(@ I _{IHTP} = 100 μA Max) | VIHTP | 9.0 | 12.0 | 15.0 | ٧ |

MC68705U3 AND MC68705U5

11.7.2 Electrical Characteristics ($V_{CC} = +5.25 \text{ Vdc} \pm 0.5 \text{ Vdc}$, $V_{SS} = 0 \text{ Vdc}$, $T_A = 0^{\circ}$ to 70°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|-------------------|---|---------------------------|------------------------------|---------------------|
| Input High Voltage RESET (4.99≤V _{CC} ≤5.51) (V _{CC} <4.75) INT (4.99≤V _{CC} ≤5.51) (V _{CC} <4.75) All Other | Vін | 4.0 V _{CC} -0.5 4.0 V _{CC} -0.5 2.0 | - ++ ++ | VCC VCC VCC VCC | ٧ |
| Input High Voltage (TIMER Pin) Timer Mode Bootstrap Programming Mode | VIH | 2.0 9.0 | _ 12.0 | V _{CC} +1.0 | ٧ |
| Input Low Voltage RESET INT All Other | V _{IL} | V _{SS} V _{SS} V _{SS} | - ** - | 0.8 1.5 0.8 | ٧ |
| Internal Power Dissipation (No Port Loading, $V_{CC}=5.25 \text{ V}$ T _A = 0°C for Steady-State Operation) $T_{A}=-40$ °C | PINT | <u>-</u> | 520 580 | 740 800 | mW |
| Input Capacitance XTAL All Other | C _{in} | - | 25 10 | - | pF |
| INT Zero-Crossing Voltage, through a Capacitor | VINT | 2.0 | _ | 4.0 | V _{ac p-p} |
| RESET Hysteresis Voltage (See Figure 7-1) Out of Reset Voltage Into Reset Voltage | VIRES+ VIRES- | 2.1 0.8 | <u>-</u> | 4.0 2.0 | ٧ |
| Programming Voltage (Vpp Pin) Programming EPROM Operating Mode | V _{PP} * | 20.0 4.75 | 21.0 V _{CC} | 22.0 5.75 | ٧ |
| Input Current TIMER (Vin = 0.4 V) INT (Vin = 0.4 V) EXTAL (Vin = 2.4 V to V _{CC} Crystal Option) (Vin = 0.4 V Crystal Option) RESET (Vin = 0.8 V) (External Capacitor Changing Current) | l _{in} | - - - - -4.0 | 20 _ _ _ | 20 50 10 1600 40 | μΑ |

^{*}Vpp is Pin 7 on the MC68705U3 and MC68705U5 and is connected to Vcc in the Normal Operating Mode. In the MC6805U2. Pin 7 is NUM and is connected to Vss in the Normal Operating Mode. The user must allow for this difference when emulating the MC6805U2 ROM-based MCU.

11.7.3 Switching Characteristics (V_{CC} = +5.25 Vdc, ± 0.5 V, V_{SS} =0 Vdc, T_{A} =0° to 70°C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | Unit |
|--|------------------|------------------------|-----|-----|------|
| Oscillator Frequency Normal | fosc | 0.4 | _ | 4.2 | MHz |
| Instruction Cycle Time (4/f _{osc}) | tcyc | 0.950 | _ | 10 | μS |
| INT, INT2, or Timer Pulse Width | tWL, tWH | t _{cyc} + 250 | _ | - | ns |
| RESET Pulse Width | ^t RWL | t _{cyc} + 250 | _ | - | ns |
| RESET Delay Time (External Cap = 1.0 µF) | ^t RHL | 100 | - | - | ms |
| INT Zero Crossing Detection Input Frequency | fINT | 0.03 | _ | 1.0 | kHz |
| External Clock Duty Cycle (EXTAL) | | 40 | 50 | 60 | % |
| Crystal Oscillator Start-Up Time* | - | _ | _ | 100 | ms |

^{*}See Figure 7-5 for typical crystal parameters.

^{**}Due to internal biasing, this input (when not used) floats to approximately 2.0 V.

MC68705U3 AND MC68705U5

11.7.4 Port Electrical Characteristics ($V_{CC} = +5.25 \text{ Vdc} \pm 0.5 \text{ Vdc}$, $V_{SS} = 0 \text{ Vdc}$, $T_A = 0^{\circ}$ to 70° C unless otherwise noted)

| Characteristic | Symbol | Min | Тур | Max | · Unit |
|---|------------------|-----------------------|-----|------|--------|
| Port | A | | | | |
| Output Low Voltage, I _{Load} = 1.6 mA | VOL | _ | _ | 0.4 | ٧ |
| Output High Voltage, I _{Load} = -100 μA | Voн | 2.4 | - | - | ٧ |
| Output High Voltage, I _{Load} = -10 μA | Voн | V _{CC} – 1.0 | _ | _ | ٧ |
| Input High Voltage, $I_{Load} = -300 \mu\text{A}$ (Max) | Vін | 2.0 | _ | Vcc | ٧ |
| Input Low Voltage, I _{Load} = -500 µA (Max) | VIL | Vss | _ | 0.8 | ٧ |
| Hi-Z State Input Current (Vin=2.0 V to VCC) | Iн | _ | _ | -300 | μΑ |
| Hi-Z State Input Current (Vin=0.4 V) | կլ | _ | _ | -500 | μΑ |
| Port | В | | | | |
| Output Low Voltage, I _{Load} = 3.2 mA | VOL | _ | | 0.4 | ٧ |
| Output Low Voltage, I _{Load} = 10 mA (Sink) | VOL | _ | _ | 1.0 | V |
| Output High Voltage, ILoad= -200 µA | Voн | 2.4 | _ | - | V |
| Darlington Current Drive (Source), V _O = 1.5 V | ЮН | -1.0 | _ | -10 | mA |
| Input High Voltage | VIH | 2.0 | | Vcc | V |
| Input Low Voltage | VIL | VSS | - | 0.8 | V |
| Hi-Z State Input Current | ITSI | | <2 | 10 | μΑ |
| Port (| <u> </u> | | | | |
| Output Low Voltage, I _{Load} = 1.6 mA | VOL | | | 0.4 | V |
| Output High Voltage, I _{Load} = -100 μA | Voн | 2.4 | _ | | V |
| Input High Voltage | V _{IH} | 2.0 | _ | Vcc | V |
| Input Low Voltage | VIL | ٧ss | _ | 0.8 | V |
| Hi-Z State Input Current | ^I TSI | | <2 | 10 | μΑ |
| Port D (Inp | ut Only) | | | | |
| Input High Voltage | VIH | 2.0 | _ | Vcc | V |
| Input Low Voltage | V _{IL} | Vss | | 0.8 | V |
| Input Current | l _{in} | _ | <1 | 5 | μА |

11.8 I/O CHARACTERISTICS

Figures 11-5 through 11-15 illustrate I/O characteristic data for HMOS M6805 Family devices. Simplified port logic diagrams are shown in Figures 11-16 and 11-17, typical input protection in Figure 11-18, and an I/O characteristic measurement circuit in Figure 11-19. The I/O characteristic curves and logic diagrams are intended to allow the system designer to interface the M6805 in a variety of applications where non-TTL loading conditions exist.

A minimum specification curve (included with V_{OH} vs I_{OH} charts only) is provided as a guaranteed limit of performance under the conditions shown. The expected minimum and maximum curves in each figure represent the anticipated performance window under normal manufacturing and operating conditions. A typical curve also is illustrated indicating performance under nominal conditions.

Figure 11-15 represents the variation of IDD with temperature and VDD for a typical M6805 Family device. As shown, IDD varies directly with VDD and inversely with temperature.

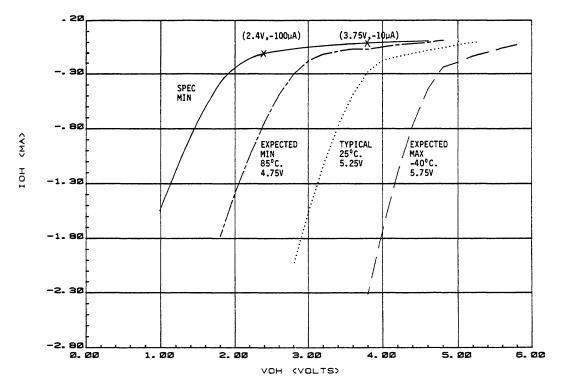


Figure 11-5. Port A VOH vs IOH (with CMOS Pull-ups)

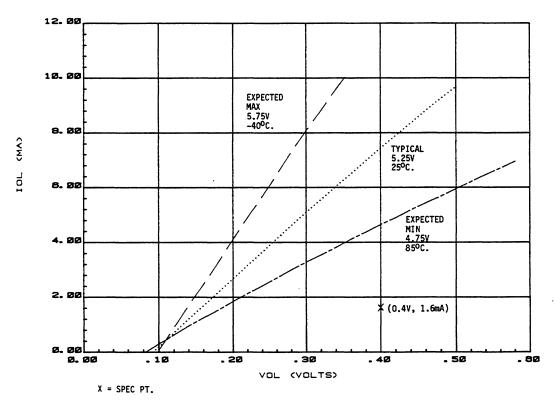


Figure 11-6. Port A VOL vs IOL (with CMOS Pull-ups)

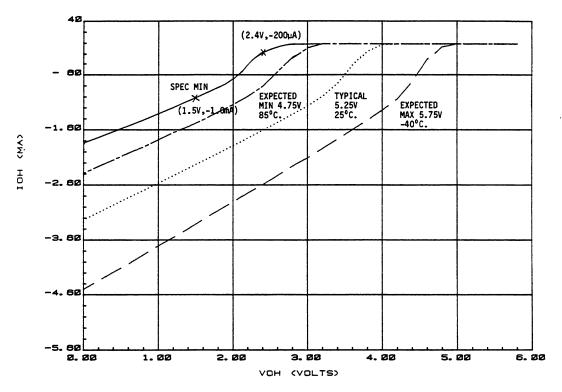


Figure 11-7. Port B VOH vs IOH

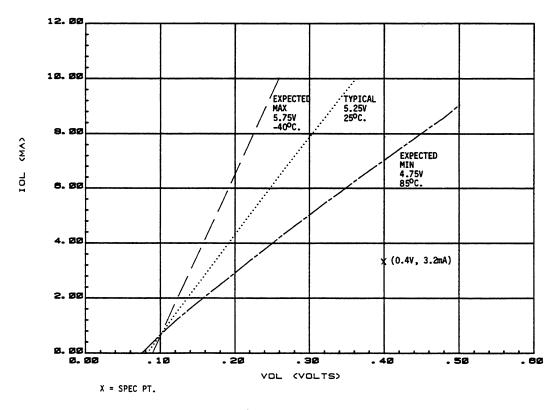


Figure 11-8. Port B VOL vs IOL

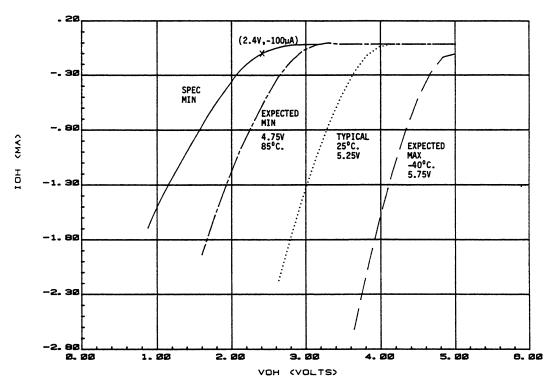


Figure 11-9. Port C VOH vs IOH (Port A Without CMOS Pull-ups)

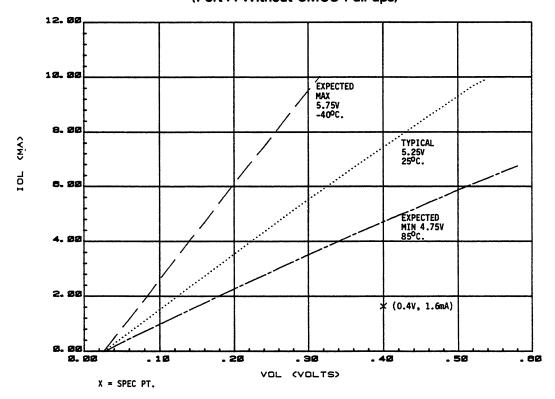


Figure 11-10. Port C VOL vs IOL (Port A Without CMOS Pull-ups)

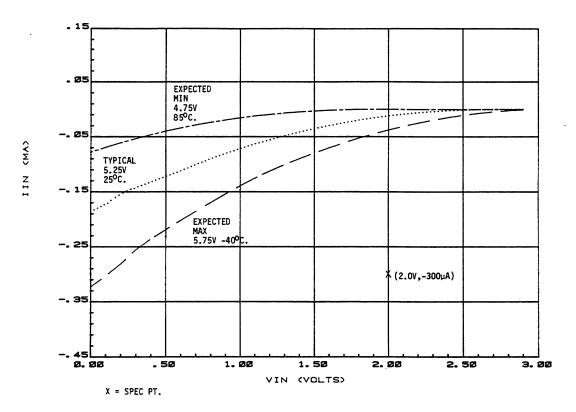


Figure 11-11. Port A V_{in} vs I_{in} (with CMOS Pull-ups)

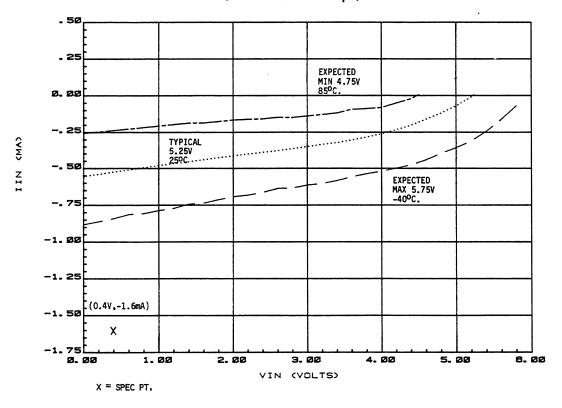


Figure 11-12. EXTAL Vin vs Iin

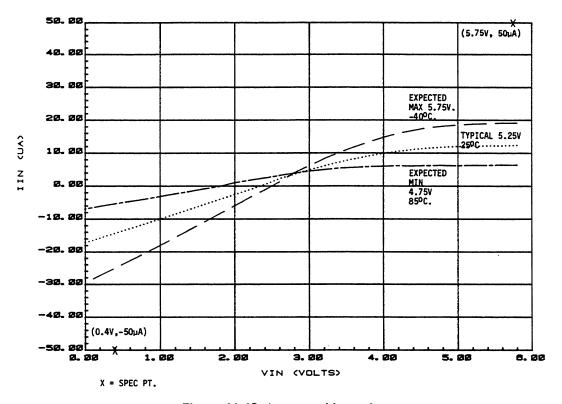


Figure 11-13. Interrupt Vin vs Iin

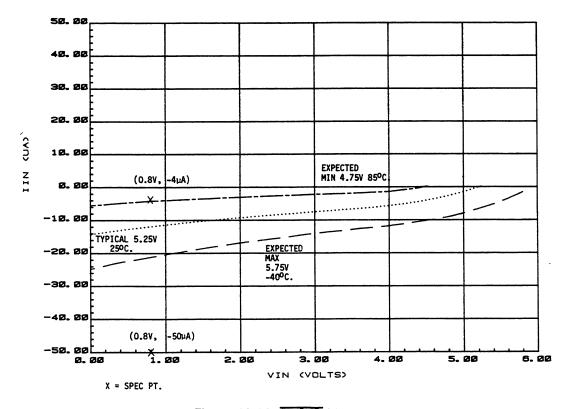


Figure 11-14. RESET Vin vs Iin

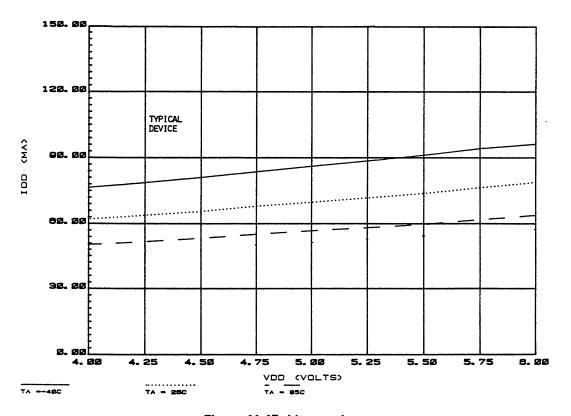
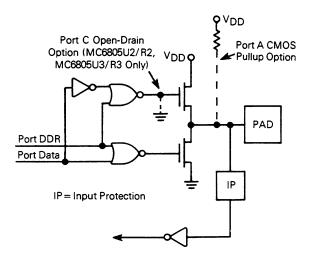


Figure 11-15. VDD vs IDD (Variation with Temperature)



PB DDR
PB Data

IP = Input Protection

IP = Input Protection

Figure 11-16. Ports A and C Logic Diagram

Figure 11-17. Port B Logic Diagram

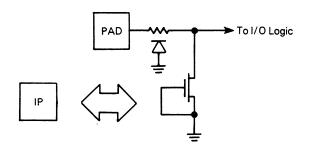


Figure 11-18. Typical Input Protection

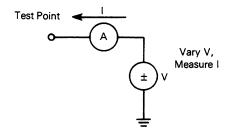


Figure 11-19. I/O Characteristic Measurement Circuit

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|---|---|--|--|
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SECTION 12 ORDERING INFORMATION

This section contains detailed information to be used as a guide when ordering an MC68(7)05 series device.

12.1 MC6805R2

| Package Type | Temperature | Generic Number |
|--------------|----------------|----------------|
| Ceramic | 0°C to 70°C | MC6805R2L |
| L Suffix | - 40°C to 85°C | MC6805R2CL |
| Plastic | 0°C to 70°C | MC6805R2P |
| P Suffix | 40°C to 85°C | MC6805R2CP |
| Cerdip | 0°C to 70°C | MC6805R2S |
| S Suffix | - 40°C to 85°C | MC6805R2CS |

12.2 MC6805R3

| Package Type | Temperature | Generic Number |
|--------------|----------------|----------------|
| Ceramic | 0°C to 70°C | MC6805R3L |
| L Suffix | 40°C to 85°C | MC6805R3CL |
| Plastic | 0°C to 70°C | MC6805R3P |
| P Suffix | 40°C to 85°C | MC6805R3CP |
| Cerdip | 0°C to 70°C | MC6805R3S |
| S Suffix | - 40°C to 85°C | MC6805R3CS |

12.3 MC6805U2

| Package Type | Temperature | Generic Number |
|--------------|----------------|----------------|
| Ceramic | 0°C to 70°C | MC6805U2L |
| L Suffix | 40°C to 85°C | MC6805U2CL |
| Plastic | 0°C to 70°C | MC6805U2P |
| P Suffix | - 40°C to 85°C | MC6805U2CP |
| Cerdip | 0°C to 70°C | MC6805U2S |
| S Suffix | - 40°C to 85°C | MC6805U2CS |

12.4 MC6805U3

| Package Type | Temperature | Generic Number |
|--------------|----------------|----------------|
| Ceramic | 0°C to 70°C | MC6805U3L |
| L Suffix | - 40°C to 85°C | MC6805U3CL |
| Plastic | 0°C to 70°C | MC6805U3P |
| P Suffix | 40°C to 85°C | MC6805U3CP |
| Cerdip | 0°C to 70°C | MC6805U3S |
| S Suffix | 40°C to 85°C | MC6805U3CS |

12.5 MC68705R3

| Package Type | Temperature | Generic Number |
|--------------|----------------|----------------|
| Ceramic | 0°C to 70°C | MC68705R3L |
| L Suffix | – 40°C to 85°C | MC68705R3CL |

12.6 MC68705R5

| Package Type | Temperature | Generic Number MC68705R5L MC68705R5CL | |
|---------------------|-------------------------------|--|--|
| Ceramic L Suffix | 0°C to 70°C - 40°C to 85°C | | |
| Cerdip S Suffix | 0°C to 70°C 40°C to 85°C | MC68705R5S MC68705R5CS | |

12.7 MC68705U3

| Package Type | Temperature | Generic Number |
|--------------|--------------|----------------|
| Ceramic | 0°C to 70°C | MC68705U3L |
| L Suffix | 40°C to 85°C | MC68705U3CL |

12.8 MC68705U5

| Package Type | Temperature | Generic Number | |
|--------------|----------------|----------------|--|
| Ceramic | 0°C to 70°C | MC68705U5L | |
| L Suffix | - 40°C to 85°C | MC68705U5CL | |
| Cerdip | 0°C to 70°C | MC68705U5S | |
| S Suffix | 40°C to 85°C | MC68705U5CS | |

12.9 CUSTOM MCUs

The information required when ordering a custom MCU is listed below. The ROM program may be transmitted to Motorola on EPROM(s) or an MDOS disk file.

To initiate a ROM pattern for the MCU it is necessary to first contact your local Motorola representative or Motorola distributor.

12.9.1 EPROMs

The MCM2716 or MCM2532 type EPROMs, programmed with the customer program (positive logic sense for address and data), may be submitted for pattern generation. The EPROM must be clearly marked to indicate which EPROM corresponds to which address space. The recommended marking procedure for two MCM2716 EPROMs is shown in Figure 12-1.

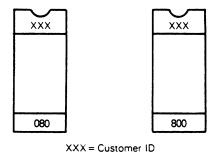


Figure 12-1. Recommended Marking Procedure

After the EPROM(s) are marked, they should be placed in conductive IC carriers and securely packed. Do not use styrofoam.

12.9.2 Verfication Media

All original pattern media (EPROMs or floppy disk) are filed for contractural purposes and are not returned. A computer listing of the ROM code will be generated and returned along with a listing verification form. The listing should be thoroughly checked and the verification form completed, signed, and returned to Motorola. The signed verification form constitutes the contractual agreement for creation of the customer mask. If desired, Motorola will program one blank EPROM from the data file used to create the custom mask to aid in the verification process.

12.9.3 ROM Verification Units (RVUs)

Ten MCUs containing the customer's ROM pattern will be sent for program verification. These units will have been made using the custom mask but are for the purpose of ROM verification only. For expediency they are usually unmarked, packaged in ceramic, and tested only at room temperature and 5 volts. These RVUs are included in the mask charge and are not production parts. Therefore, the RVUs are not guaranteed by Motorola Quality Assurance, and should be discarded after verification is completed.

12.9.4 Flexible Disk

The disk media submitted must be single-sided, single-density, 8-inch MDOS compatible floppies. The customer must write the binary file name and company name on the disk with a felt-tip pen. The minimum MDOS system files as well as the absolute binary object file (filename .LO type of file) from the M6805 cross assembler must be on the disk. An object file made from a memory dump using the ROLLOUT command is also acceptable. Consider submitting a source listing as well as the following files: filename .LX (EXORciser loadable format) and filename .SA (ASCII source code). These files will of course be kept confidential and are used 1) to speed up the process in-house if any problems arise, and 2) to speed up the user-to-factory interface if the user finds any software errors and needs assistance quickly from Motorola factory representatives.

MDOS is Motorola's Disk Operating System available on development systems such as EXOR-cisers, EXORsets, etc.

EXORset and MDOS are trademarks of Motorola Inc.

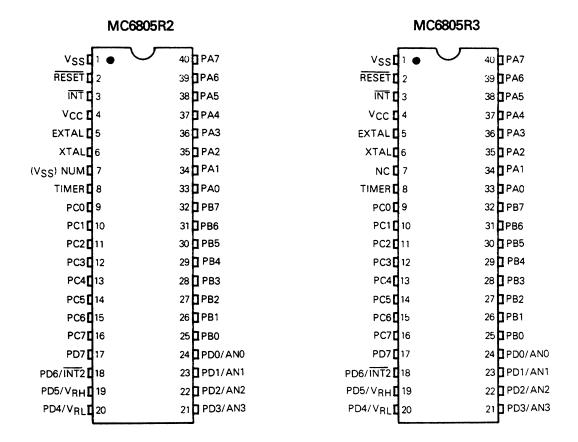
| Date | | Customer PO Numb | per |
|---|---|--|--|
| Customer Company | | | Notorola Part Number |
| Address | | S | C |
| City | State | · | Zip |
| Country | | | |
| Phone | | Extens | ion |
| Customer Contact Perso | on | | |
| Customer Part Number | | | |
| | | | |
| • | | R3/U3 OPTION LIST In the following list. A | manufacturing mask |
| Internal Oscillator Input Crystal Resistor | | Timer Clock Source MC6805R2/U2 Only ☐ Internal ø2 clock ☐ TIMER input pin | MC6805R2/U2 Only □ 2 ⁰ (divide by 1) □ 2 ¹ (divide by 2) |
| Port A Output Drive CMOS and TTL TTL Only | | | ☐ 2 ² (divide by 4) ☐ 2 ³ (divide by 8) ☐ 2 ⁴ (divide by 16) ☐ 2 ⁵ (divide by 32) ☐ 2 ⁶ (divide by 64) ☐ 2 ⁷ (divide by 128) |
| ☐ Floppy Disk | er media requires prior 2716 or MCM2532) | | - |
| Clock Frequency | | | _ |
| Temperature Range | | | 0°C to +70°C (Standard) -40°C to +85°C -40°C to +105°C |
| Marking Information (12 | Characters Maximum |) | |
| Title | | | |
| Signature | | | |

Figure 12-2. Sample Custom MCU Order Form

SECTION 13 MECHANICAL DATA

This section contains the pin assignments and package dimensions for the MC68(7)05 series devices.

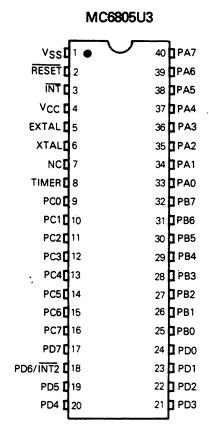
13.1 PIN ASSIGNMENT



MC6805U2 40 PA7 VSS 1 RESET 2 39 PA6 iNT ₫ 3 38 PA5 VCC d4 37 PA4 EXTAL 5 36 PA3 XTAL 6 35 PA2 34 PA1 (VSS) NUMI 7 TIMER 4 33 PA0 PC0**[**9 32 PB7 PC1 10 31 PB6 30 PB5 PC2 11 29 PB4 PC3[12 PC4[13 28 PB3 PC5 14 27 PB2 26 PB1 PC6 15 PC7[16 25 PB0 PD7 17 24 D PD0 PD6/INT2 18 23 PD1 PD5 🗖 19 22 PD2

PD4 **1**20

21 PD3



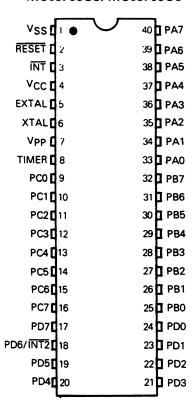
MC68705R3/MC68705R5

Vss**₫**1 40 PA7 39 PA6 RESET 1 2 INT [3 38 D PA5 VCC d 4 3/ PA4 36 PA3 EXTAL 6 35 PA2 XTAL 6 VPP / 34 PA1 33 PA0 TIMER 18 32 PB7 PC0 **d** 9 31 PB6 PC1 10 30 PB5 PC2 11 29 PB4 PC3 12 28 1 PB3 PC4 13 2/ PB2 PC5 14 PC6**₫**15 26 PB1 25 PB0 PC7 16 PD7 17 24 PD0/AN0 23 PD1/AN1 PD6/INT2 18 PD5/VRH 19 22 PD2/AN2

PD4/V_{RL} 1 20

21 PD3/AN3

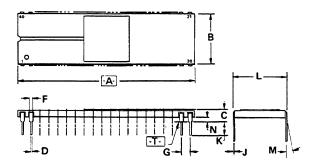
MC68705U3/MC68705U5



13.2 PACKAGE DIMENSIONS

13.2.1 Ceramic — MC6805R2, MC6805R3, MC6805U2, MC6805U3

L SUFFIX CERAMIC PACKAGE CASE 715-05



NOTES:

- 1. DIMENSION -A- IS DATUM.
- 2. POSITIONAL TOLERANCE FOR LEADS:

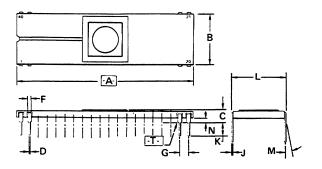
⊕ 0.25 (0.010) ⋒ T A⋒

- 3. T. IS SEATING PLANE.
- 4. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.

| | MILLIM | ETERS | INC | HES |
|-----|--------|----------|-------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 50.29 | 51.31 | 1.980 | 2.020 |
| В | 14.63 | 15.49 | 0.576 | 0.610 |
| С | 2.79 | 4.32 | 0.110 | 0.170 |
| D | 0.38 | 0.53 | 0.015 | 0.021 |
| F | 0.76 | 1.52 | 0.030 | 0.060 |
| G | 2.54 | 2.54 BSC | | BSC |
| J | 0.20 | 0.33 | 0.008 | 0.013 |
| K | 2.54 | 4.57 | 0.100 | 0.180 |
| L | 14.99 | 15.65 | 0.590 | 0.616 |
| M | _ | 100 | _ | 10º |
| N | 1.02 | 1.52 | 0.040 | 0.060 |

13.2.2 Ceramic - MC68705R3, MC68705R5, MC68705U3, MC68705U5

L SUFFIX CERAMIC PACKAGE CASE 715-06



- 1. DIMENSION -A- IS DATUM.
 2. POSITIONAL TOLERANCE FOR LEADS:

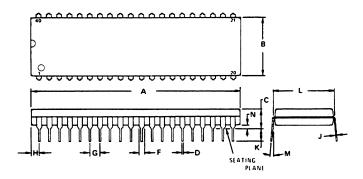
⊕ 0.25 (0.010) **⊚ T A⊚**

- 3. T- IS SEATING PLANE.
- 4. DIMENSION "L" TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 5. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.

| | MILLIM | ETERS | INCHES | |
|-----|----------|-------|-----------|-------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 50.29 | 51.31 | 1.980 | 2.020 |
| В | 14.63 | 15.49 | 0.576 | 0.610 |
| C | 3.18 | 5.08 | 0.125 | 0.200 |
| D | 0.38 | 0.53 | 0.015 | 0.021 |
| F | 0.76 | 1.52 | 0.030 | 0.060 |
| G | 2.54 BSC | | 0.100 BSC | |
| J | 0.20 | 0.33 | 0.008 | 0.013 |
| K | 2.54 | 4.57 | 0.100 | 0.180 |
| L | 14.99 | 15.65 | 0.590 | 0.616 |
| M | - | 100 | _ | 100 |
| N | 1.02 | 1.52 | 0.040 | 0.060 |

13.2.3 Plastic - MC6805R2, MC6805R3, MC6805U2, MC6805U3

P SUFFIX PLÁSTIC PACKAGE CASE 711-01



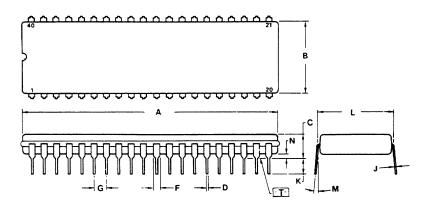
NOTES:

- 1. POSITIONAL TOLERANCE OF LEADS (D), SHALL BE WITHIN 0.25 mm (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.
- 2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

| | MILLIMETERS | | INCHES | |
|-----|-------------|-------|-----------|-----------------|
| DIM | MIN | MAX | MIN | MAX |
| Α | 51.69 | 52.45 | 2.035 | 2.065 |
| В | 13.72 | 14.22 | 0.540 | 0.560 |
| C | 3.94 | 5.08 | 0.155 | 0.200 |
| D | 0.36 | 0.56 | 0.014 | 0.022 |
| F | 1.02 | 1.52 | 0.040 | 0.060 |
| G | 2.54 BSC | | 0.100 BSC | |
| Н | 1.65 | 2.16 | 0.065 | 0.085 |
| - | 0.20 | 0.38 | 0.008 | 0.015 |
| K | 2.92 | 3.43 | 0.115 | 0.135 |
| L | 15.24 BSC | | 0.600 | BSC |
| M | Oo | 150 | 00 | 15 ⁰ |
| N | 0.51 | 1.02 | 0.020 | 0.040 |

13.2.4 Cerdip — MC6805R2, MC6805R3, MC6805U2, MC6805U3

S SUFFIX CERDIP PACKAGE CASE 734-03



NOTES:

- 1. DIM -A- IS DATUM.
- 2. POSITIONAL TOLERANCE FOR LEADS:
 - **♦** Ø 0.25(0.010) M T A M
- 3. T. IS SEATING PLANE.
- 4. DIM L TO CENTER OF LEADS WHEN FORMED PARALLEL.
- 5. DIMENSIONS A AND B INCLUDE MENISCUS..
- 6. DIMENSIONING AND TOLERANCING PER ANSI Y14.5, 1973.

| | MILLIMETERS | | INCHES | | |
|-----|-------------|-----------------|-----------|-----------------|--|
| DIM | MIN | MAX | MIN | MAX | |
| Α | 51.31 | 53.24 | 2.020 | 2.096 | |
| В | 12.70 | 15.49 | 0.500 | 0.610 | |
| С | 4.06 | 5.84 | 0.160 | 0.230 | |
| D | 0.38 | 0.56 | 0.015 | 0.022 | |
| F | 1.27 | 1.65 | 0.050 | 0.065 | |
| G | 2.54 | 2.54 BSC | | BSC | |
| J | 0.20 | 0.30 | 800.0 | 0.012 | |
| K | 3.18 | 4.06 | 0.125 | 0.160 | |
| L | 15.24 BSC | | 0.600 BSC | | |
| М | 50 | 15 ⁰ | 50 | 15 ⁰ | |
| N | 0.51 | 1.27 | 0.020 | 0.050 | |

